SFF specifications are available at http://www.snia.org/sff/specifications or ftp://ftp.seagate.com/sff

This specification was developed by the SFF Committee prior to it becoming the SFF TA (Technology Affiliate) TWG (Technical Working Group) of SNIA (Storage Networking Industry Association).

The information below should be used instead of the equivalent herein.

POINTS OF CONTACT:

Chairman SFF TA TWG Email: SFF-Chair@snia.org

If you are interested in participating in the activities of the SFF TWG, the membership application can be found at: http://www.snia.org/sff/join

The complete list of SFF Specifications which have been completed or are currently being worked on can be found at: http://www.snia.org/sff/specifications/SFF-8000.TXT

The operations which complement the SNIA's TWG Policies & Procedures to guide the SFF TWG can be found at: http://www.snia.org/sff/specifications/SFF-8032.PDF

Suggestions for improvement of this specification will be welcome, they should be submitted to:

http://www.snia.org/feedback

** Information Specification **

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SFF Committee

INF-8478i Specification for

OC48 DWDM Pluggable Transceiver

Rev 3.0 May 30 2003

Secretariat: SFF Committee

Abstract: This specification describes the OC48 DWDM Pluggable Transceiver. It was developed by the MSA (Multiple Source Agreement) group in which the following companies participated:

Agilent	NEC
Alcatel Optronics	OKI
Bookham Technology	Sumitomo/Excelight
JDSU	Triquint Optoelectronics
Mitsubishi	

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Contributors are not required to abide by the SFF patent policy. Readers are advised of the possibility that there may be patent issues associated with an implementation which relies upon the contents of an 'i' specification.

SFF accepts no responsibility for the validity of the contents.

POINTS OF CONTACT:

Dan Rausch Technical Editor Avago Technologies 350 West Trimble Rd San Jose CA 95131

408-435-6689 dan.rausch@avagotech.com I. Dal Allan Chairman SFF Committee 14426 Black Walnut Court Saratoga CA 95070

408-867-6630 endlcom@acm.org

EXPRESSION OF SUPPORT BY MANUFACTURERS

The following member companies of the SFF Committee voted in favor of this industry specification.

The following member companies of the SFF Committee voted against this industry specification.

The following member companies of the SFF Committee voted to abstain on this industry specification.

SFF COMMITTEE

The SFF Committee is an industry group. The membership of the committee since its formation in August 1990 has included a mix of companies which are leaders across the industry.

When 2 1/2" diameter disk drives were introduced, there was no commonality on external dimensions e.g. physical size, mounting locations, connector type, connector location, between vendors.

The first use of these disk drives was in specific applications such as laptop portable computers and system integrators worked individually with vendors to develop the packaging. The result was wide diversity, and incompatibility.

The problems faced by integrators, device suppliers, and component suppliers led to the formation of the SFF Committee as an industry ad hoc group to address the marketing and engineering considerations of the emerging new technology.

During the development of the form factor definitions, other activities were suggested because participants in the SFF Committee faced more problems than the physical form factors of disk drives. In November 1992, the charter was expanded to address any issues of general interest and concern to the storage industry. The SFF Committee became a forum for resolving industry issues that are either not addressed by the standards process or need an immediate solution.

Those companies which have agreed to support a specification are identified in the first pages of each SFF Specification. Industry consensus is not an essential requirement to publish an SFF Specification because it is recognized that in an emerging product area, there is room for more than one approach. By making the documentation on competing proposals available, an integrator can examine the alternatives available and select the product that is felt to be most suitable.

SFF Committee meetings are held during T10 weeks (see www.t10.org), and Specific Subject Working Groups are held at the convenience of the participants. Material presented at SFF Committee meetings becomes public domain, and there are no restrictions on the open mailing of material presented at committee meetings.

Most of the specifications developed by the SFF Committee have either been incorporated into standards or adopted as standards by EIA (Electronic Industries Association), ANSI (American National Standards Institute) and IEC (International Electrotechnical Commission).

Suggestions for improvement of this specification will be welcome. They should be sent to the SFF Committee, 14426 Black Walnut Ct, Saratoga, CA 95070.

The complete list of SFF Specifications which have been completed or are currently being worked on by the SFF Committee can be found at:

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ftp://ftp.seagate.com/sff/SFF-8000.TXT
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If you wish to know more about the SFF Committee, the principles which guide the activities can be found at:

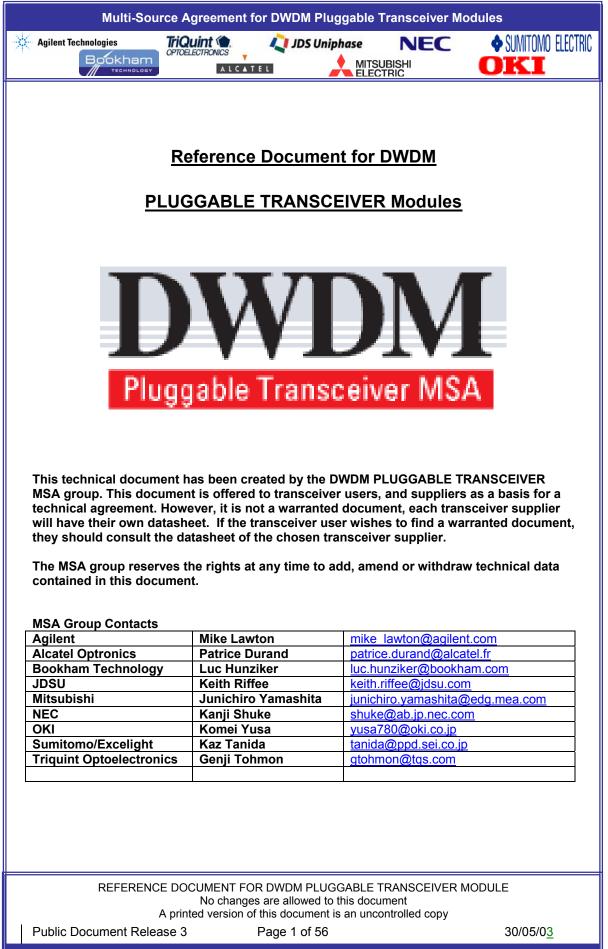
ftp://ftp.seagate.com/sff/SFF-8032.TXT

If you are interested in participating or wish to follow the activities of the SFF Committee, the signup for membership and/or documentation can be found at:

www.sffcommittee.com/ie/join.html

or the following application can be submitted.

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	Version	Date	Comments	
-	Release 1	28 May, 2002	First Release	
-	Release 2 Release 3	09 Sep, 2002 30 May, 2003	Updates from latest MSA Technical Document meeting Updates from latest MSA Technical Document meeting	
-	Release 3	50 May, 2003		5.
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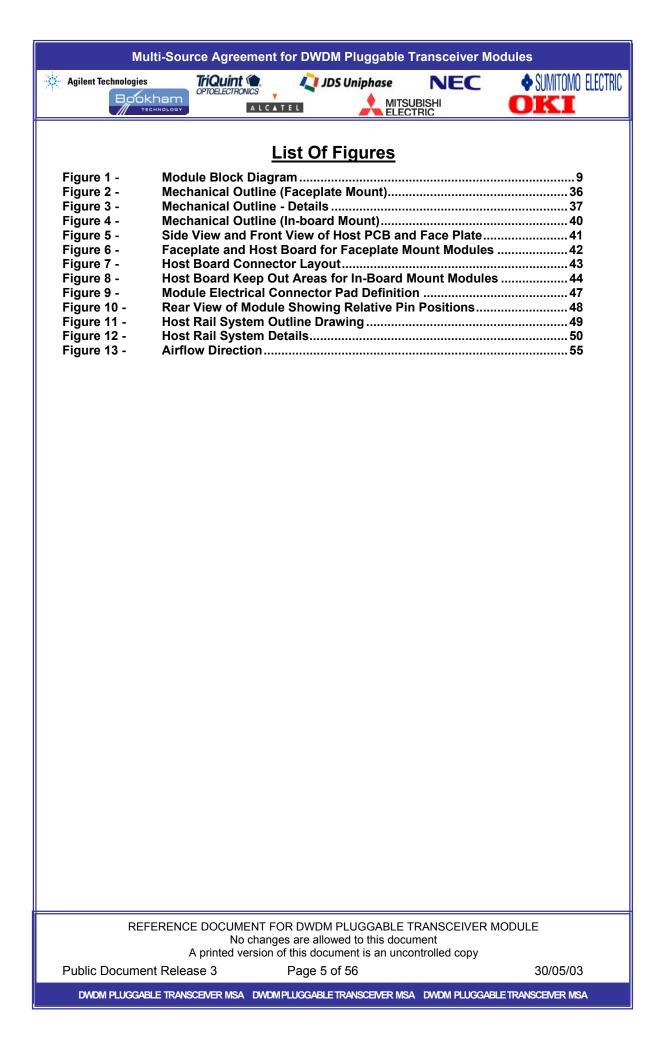
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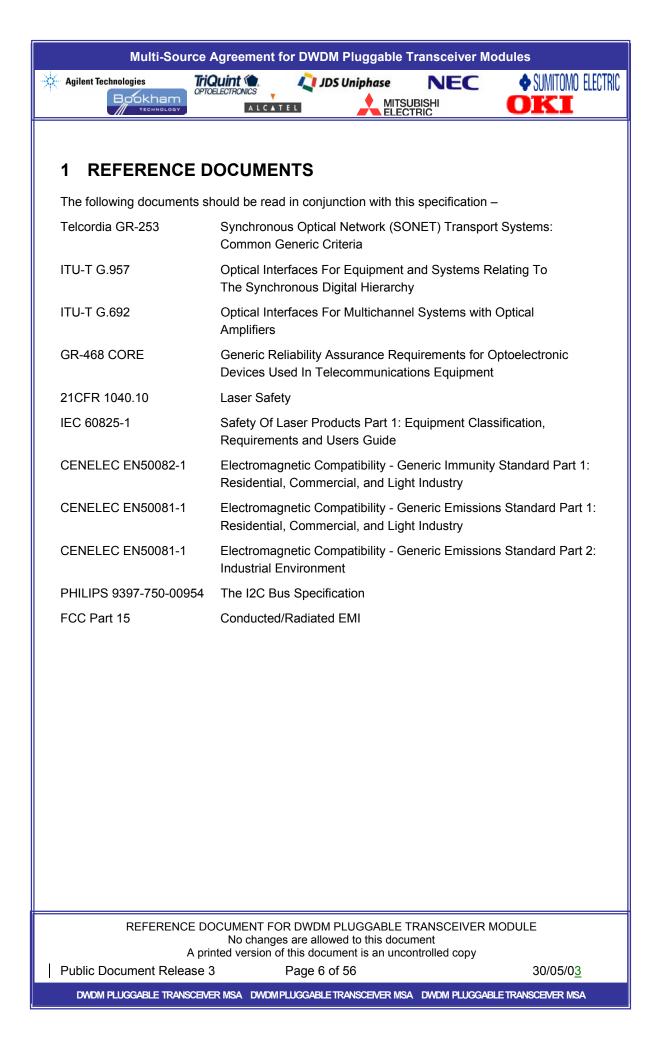
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2 GLOS	SSARY			
ITU-T	International Telecommunication Union - Telecommunication			
SDH	Synchronous Digital Hierarchy			
SONET	Synchronous Optical Network			
PRBS	Pseudo Random Binary Sequence			
APD	Avalanche Photo-Diode			
LVCMOS	Low Voltage Complimentary Metal Oxide Semiconductor			
CML	Current Mode Logic			
DWDM	Dense Wavelength Division Multiplex			
TEC	Thermo-Electric Cooler			
SFP	Small Form Pluggable			
NRZ	Non-Return to Zero			
CDR	Clock and Data Recovery			

3 MANDATORY AND OPTIONAL FEATURES

Italics in tables of this document are used to signify optional features. Features shown in tables as **bold text** are absolute minimum requirements for being DWDM PLUGGABLE MSA compatible.

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4 OVERVIEW

The OC48 DWDM PLUGGABLE Module is an advanced, highly integrated, long reach ITU & SONET transceiver, which converts optical signals to and from serial electrical signals. The module wavelength is compliant to the ITU DWDM 50/100GHz wavelength grid covering the C-band (L-Band wavelengths available refer to transceiver vendor datasheet). The module features very high functionality and feature integration, accessible via a two-wire serial (I2C) interface. Electrical connection is made through a 70-pin gold plated edge connector, and the optical interface is via receptacle connector(s). The mechanical outline of the module, and rail system design, enable <u>front panel</u> and in-board mountable modules with respect to the host card. The module operates from a single 3.3V supply.

The OC48 DWDM PLUGGABLE Transceiver has been developed to be a highly flexible platform upon which MSA vendors can build a variety of products for many different customer applications. Several examples of module features that can be implemented on this platform include:

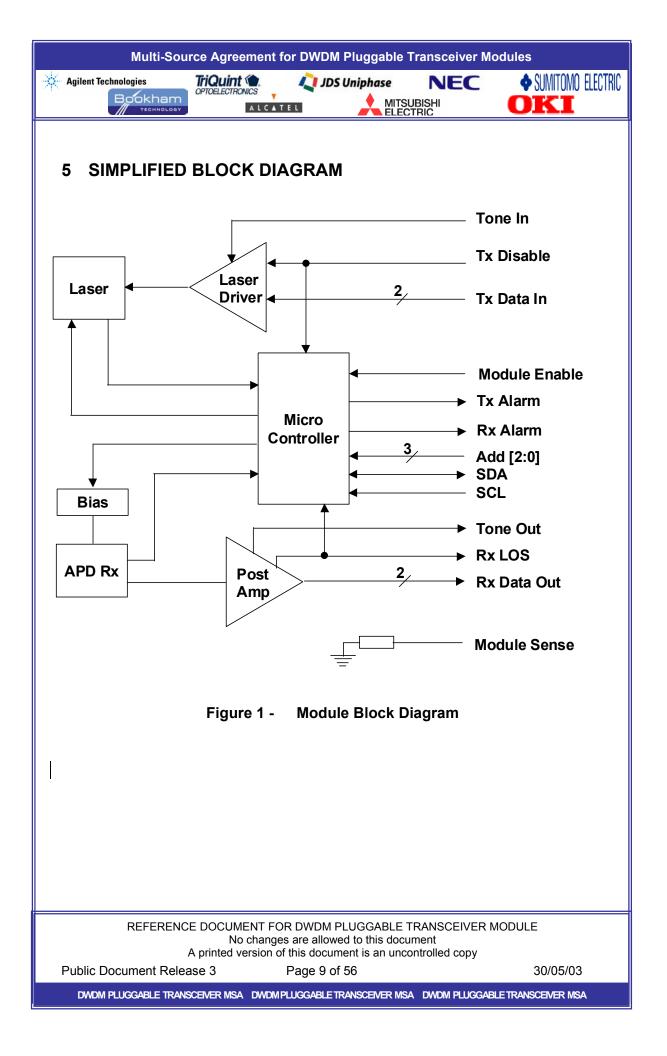
- Operating data rates from 155Mb/s to 2.7Gb/s with an upgrade path to provide a 10Gb/s serial transceiver
- Fiber optic link lengths from 40km to 650km
- Wavelengths compliant to the ITU DWDM 50/100GHz grid covering the C band and/or L band
- Temperature or electrical tunability from two ITU channels up to the entire C or L band
- Decision threshold control of the receiver allowing increased sensitivity over amplified links
- An integrated Variable Optical Attenuator (VOA)
- Wide range of optical output power levels
- OC48 transceiver, transmitter-only, and receiver-only operation at LR-1, LR-2, CWDM, and DWDM
- Optional clock and data recovery at one or more data rates
- Receiver bandwidth adjustment to provide higher sensitivity at lower data rates
- Tone injection and detection

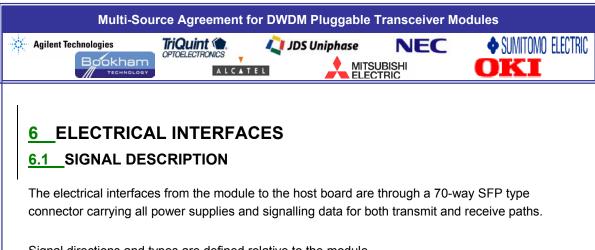
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Signal Classification		10	T	Provide the
Group	Name	I/O	Туре	Description
Data	Tx Data (+ve) ⁴	Input	CML	Tx data bit normal
Data	Tx Data (-ve) ⁴	Input	CML	Tx data bit inverted
	Tx DISABLE	Input	LVTTL ¹	Laser disable [Internal pull-up]
Control	TX ALARM	Output	LVTTL ²	Out of limits detected in Tx
	TONE IN	Input	Analogue	Low frequency tone
	Vcc (Tx)	Input	Supply	+3.3V supply for transmitter
Damas	Vcc (TEC)	Input	Supply	+3.3V supply for TEC
Power	GND (TEC)	Output	Supply ³	Ground for TEC
	GND (Tx)	Output	Supply ³	Ground for Transmitter
Clask	Tx CLK (+ve) ⁴	Input	CML	Reference clock normal
Clock	Tx CLK (-ve) ⁴	Input	CML	Reference clock inverted

Signal directions and types are defined relative to the module.

1. Interfaces to LVCMOS. Active high to disable.

2. Interfaces to LVCMOS. Active high to indicate out of limits detected.

3. Ground to be DC isolated between signal and module housing

4. The Tx Data & Tx CLK signals are AC coupled and have internal 50 Ohm termination.

Table 1 - Transmitter Signal Description

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JDS Uniphase



Signal Classification					
Group	Name	I/O Type		Description	
	Rx Data (+ve) ⁴	Out	Analogue	Rx data bit normal	
Data			or CML		
Data	Rx Data (-ve) ⁴	Out	Analogue	Rx data bit inverted	
			or CML		
	Rx ALARM	Out	LVTTL ¹	Out of limits detected in Rx	
Control	Rx LOS	Out	LVTTL ²	Receiver received signal below limits	
	Tone Out	Out	Analogue	Low frequency tone	
	Vcc (Rx)	In	Supply	+3.3V supply for Receiver	
Power	Vcc (Rx Bias)	In	Supply	+3.3V supply for APD	
Power	GND (Rx)	Out	Supply ³	Ground for Receiver	
	GND (Rx Bias)	Out	Supply ³	Ground for Receiver	
Clocks	Rx CLK (+ve) ⁴	Out	CML	Rx recovered clock normal (CDR variant only)	
CIUCKS	Rx CLK (-ve) ⁴	Out	CML	Rx recovered clock inverted (CDR variant only)	

1. Interfaces to LVCMOS. Active high to indicate out of limits detected in Rx

2. Interfaces to LVCMOS. Active high to indicate loss of received signal detected.

3. Ground to be DC isolated between signal and module housing

4. The Rx Data & Rx CLK signals are AC coupled and have internal 50 Ohm termination.

Table 2 - Receiver Signal Description

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Agilent Technol		LECTRONCS ALCATEL ALCATEL MITSUBISHI					
Signal C	Signal Classification		Туре	Description			
Group	Name	I/O	Type	Description			
_	Vcc (Digital)	In	Supply	+3.3V supply for control circuitry			
Power	GND (Digital)	Out	Supply ¹	Digital Ground			
	SDA	Input / Output	Open Collector	Serial data [External pull-up]			
	SCL	Input	Open Collector	Serial clock [External pull-up]			
	SLA-AD0:2	Input	LVTTL ²	Module address [Internal Pull-up]			
Control	MODULE SENSE	Input	Analogue	1KΩ to GND to indicate module is present			
	MODULE ENABLE	Input	LVTTL ²	Module Control [Internal Pull-down] Moves Module from standby mode, where the Tx and Rx are disabled, and the microcontroller is enabled.			

2. Interfaces to LVCMOS.

Table 3 - Control Signal Description

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6.2 INPUT / OUTPUT OPERATING PARAMETERS								
Parameter	Symbol	Min	Max	Unit				
DATA								
Operating Rate ¹		0.155	2.7	Gbps				
Differential input voltage	Vin _{diff}	400	1000	mVpk-pk				
Differential output voltage ²	Vout _{diff}	200/400	1000	mVpk-pk				
Differential input impedance	Rin	84	116	Ω				
Rx data Output rise time ³			250	ps				
Rx data Output fall time ³			250	ps				
TWO WIRE INTERFACE ⁴ (SDA / S	SCL)							
Bus Frequency	f _{max}		100	kHz				
MODULATION TONE								
Input Voltage⁵	V _{Tin}	0	2.5	Vpk-pk				
Output Voltage	V _{Tout}	0	2.5	Vpk-pk				
Bandwidth ⁶		50	500	kHz				
TX DISABLE								
Input Voltage Low	Vil		0.8	v				
Input Voltage High	Vih	2.4		v				
Disable time			50	ms				
Start up time - controlled ⁷			120	s				
Disabled power			-40	dBm				
TX ALARM								
Output Voltage Low	Vol		0.8	v				
Output Voltage High	Voh	2.4		v				
Activation Time ⁸		500	1000	ms				
De-Activation Time ⁹		500	1000	ms				

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					OÌ	
RX ALARM						
Output Voltage Low		Vol			0.8	v
Output Voltage High		Voh	2.4			v
Activation Time ⁸			500		1000	ms
De-Activation Time ⁹			500		1000	ms
RX LOS ALARM						
Output Voltage Low		Vol			0.8	v
Output Voltage High		Voh	2.4			v
Activation Time			2.3		100	μs
De-Activation Time					100	μs
Activation/Deactivation por	wer		-45		-35	dBm
Hysteresis			0.5		4	dB
MODULE SENSE	l			1		
Resistor		Rsense	900		1100	Ω
MODULE ENABLE						
Input Voltage Low		Vil			0.8	v
Input Voltage High		Vih	2.4			v
Deassert time					50	ms
Assert Time ⁷					120	s
1. ITU-T / SONET compliance	is at 2.488Gbps	i.		<u>.</u>		
2. Differential output voltage r	elates to the outp	out in AGC or li	imiting mode (200	mV analogue	/ 400mV CML	-)
 20-80% measured. Refer to 'The I2C Bus Spec 	ification'					
5. For a constant tone input vo		n depth is dete	ermined by the inte	ernal gain sett	ing, and will v	ary between
modules.63dB Bandwidths						
7. Maximum time taken for mo			power, extinction r	atio & waveler	ngth, from pov	wer up / tx
enable state over supply/ter8. Activation time includes hol		nes.				
 De-Activation time includes 						
		t / Output I	Electrical Spe	cification		
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	Multi	-Source Agreement for DWDM Pluggable Transceiver Modules
Agile	nt Technologies Bookh TECHN	
6.3		DL AND MONITORING FUNCTIONS he following control and monitor functions:
1110	Tx Disable	
	0	Normal operation
	1	Laser disabled – default state [internal 100K pull up]
	Tx Alarm	
	0	Normal operation
	1	Out of limits detected in Tx circuit [internal 100K pull up]
	Rx Alarm	
	0	Normal operation
	1	Out of limits detected in Rx circuit [internal 100K pull up]
	Rx LOS	
	0	Normal operation
	1	Received signal input below threshold
	Module Enal	ble
	0	Module Standby Default State [internal 100K pull down]
	1	Normal Operation

7 WAVELENGTH

The available wavelengths are based on the ITU-T G.692 grid from 1528.77nm to 1563.86nm with 50GHz spacing. For available wavelengths in the L-band refer to transceiver vendor datasheets.

Nominal Centre Wavelength (nm)	Optical Frequency THz	Nominal Centre Wavelength (nm)	Optical Frequency THz
1528.77	196.10	1546.52	193.85
1529.16	196.05	1546.92	193.80
1529.55	196.00	1547.32	193.75
1529.94	195.95	1547.72	193.70
1530.33	195.90	1548.11	193.65
1530.72	195.85	1548.51	193.60
1531.12	195.80	1548.91	193.55
1531.51	195.75	1549.32	193.50
1531.90	195.70	1549.72	193.45

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Nominal Waveleng 1532	Centre	ALCATEL	ELECTRIC	
Waveleng 1532				
Waveleng 1532				
Waveleng 1532				
1532		Optical Frequency THz	Nominal Centre Wavelength (nm)	Optical Frequency THz
		195.65	1550.12	193.40
1002	-	195.60	1550.52	193.35
1533		195.55	1550.92	193.30
1533		195.50	1551.32	193.25
1533		195.45	1551.72	193.20
1534		195.40	1552.12	193.15
1534		195.35	1552.52	193.10
1535		195.30	1552.93	193.05
1535		195.25	1553.33	193.00
1535		195.20	1553.73	192.95
1536		195.15	1554.13	192.90
1536	.61	195.10	1554.54	192.85
1537	.00	195.05	1554.94	192.80
1537	.40	195.00	1555.34	192.75
1537	.79	194.95	1555.75	192.70
1538	.19	194.90	1556.15	192.65
1538	.58	194.85	1556.55	192.60
1538	.98	194.80	1556.96	192.55
1539	.37	194.75	1557.36	192.50
1539	.77	194.70	1557.77	192.45
1540	.16	194.65	1558.17	192.40
1540	.56	194.60	1558.58	192.35
1540		194.55	1558.98	192.30 192.25 192.20 192.15 192.10
1541		194.50	1559.39	
1541		194.45	1559.79	
1542		194.40	1560.20	
1542		194.35	1560.61	
1542		194.30	1561.01	192.05
1543		194.25	1561.42	192.00
1543		194.20	1561.83	191.95
1544		194.15	1562.23	191.90
1544		194.10	1562.64	191.85
1544		194.05	1563.05	191.80
1545		194.00	1563.45	191.75
1545 1546		193.95	1563.86	191.70
	. 12	193.90		

ľ	Multi-So	ource Ag	greemei	nt for DV	VDM Plu	ıggable	Transc	eiver Modul	es
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8_TWO-				_			ent.		
	internae	0 0011111			atory to	quironne			
<u>8.1</u> ELEC		AL INT	ERFAG	CE					
The physical Philips I2C B	-							cification as	defined in 'The
Points to note	e include	e:							
a) The I2C r consisting								he hot plugga	able connector,
b) The bus, I2C-Bus \$, will pro	vide the	required	pull-up	resistor	s as per sect	ion 16.1 of The
c) The bus	shall ope	erate in	the 100k	kHz mod	e.				
d) Address	pins are	of LVT	ΓL type,	positive	logic.				
e) The mod until the r			hall be	sampled	once a	t power	up. Thi	s address sh	all not change
f) Address	lines hav	ve interr	nal 100k	pull-up r	esistors.				
g) The mod	ule will a	always ta	ake the I	role of a	slave an	d never	a maste	er.	
8.2 ADDF The module used for settings on the of the first fou being used for read or write wire interface	uses sta le custor ur bits of or the ha operatio	ndard 7 mer boa the add rdware	rd, by us lress byt setting.	se of DIF te set as The Leas	9 switche 0110 an st Signifi	es or har d the ne cant Bit	d-wired ext three (LSB) is	links. The for bits of the ac used to sign	mat consists Idress byte ify whether a
The format is	thus:								
		Fixed A	Address	5	Custo	omer Ac	ldress	Read/Write	•
	T ₃	T ₂	T ₁	T ₀	A ₂	A ₁	A ₀	R/nW	
Where :									
T ₃ , T ₂ , T ₁ , T ₀	: Fixed	d portior	of the a	address -	- current	ly 0110			
A ₂ , A ₁ , A ₀ :	Porti	on of the	e addres	s config	ured exte	ernally to	o the mo	dule by custo	omer
	EEEBEN	ICE DOC	-	-	-			CEIVER MODU	JLE
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R/nW:

Read/nWrite Bit – '1' signifies Read operation, '0' signifies Write operation

8.3 COMMAND STRUCTURE

All commands are one byte long. Extra data may be sent or received depending on the command. The command byte is a pre-defined hexadecimal number – in the forthcoming tables it is usually titled 'CMD Number'.

8.3.1 Sending Data

To send a command to the module, first a start condition is asserted, followed by the address of the module, with the LSb (the R/nW bit) clear. If the address matches that of the module, the module will thus acknowledge on the next clock pulse, if the module is busy it will respond with a negative acknowledge (as described in Section 8.3.7). If no further data is to be sent, a stop condition must be asserted. If more data is to be sent, the module will acknowledge each byte until the stop condition is asserted.

8.3.2 Receiving Data

To receive data from the module, e.g. temperature, first a command must be sent. After the module has received the command a START is asserted and the module is addressed for read. The master can thus clock out the appropriate number of bytes from the module. If the module is busy it will respond with a negative acknowledge (as described in 8.3.7) The master must acknowledge the module for every byte received, apart from the last byte, which the master must not acknowledge and send a STOP command. It is very important that the master does NOT acknowledge the last byte, failure to do so can result in being unable to assert the stop condition if a low value has been set on the SDA line by the module.

8.3.3 Reading From And Writing To The Memory

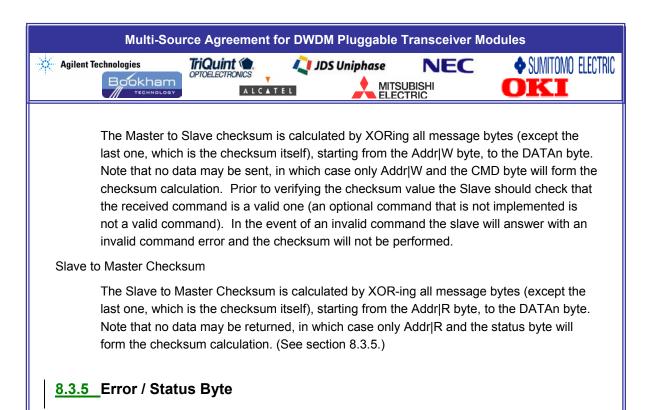
The module will offer a minimum of 32 bytes of customer read/write memory. Both the read and write functions will have their own command. An address byte is also included as part of the command structure, to indicate which location within the memory the data is being read from/written to.

8.3.4 Checksum Byte

To calculate the CHK value, the LSb of the address byte must be considered always as zero despite the value of the R/nW bit.

Master to Slave Checksum

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DWDM PLUGGABLE TRANSCEIVER MSA	DWDM PI LIGGABI E TRANSCEIVER MSA	DWDM PLUGGABLE TRANSCEIVER MSA



After each command is sent, the slave will prepare an answer to indicate the status of the command just received. This status byte will be included within the returned data stream where the command is one that requests data to be read, or to be returned as a single byte stream where the command does not require data to be read.

When the slave finds an error that causes a bit to be changed in the status byte, it should return a TYPE 6 response on receipt of a read enabled address from the master. The master will recognise that there has been an error by the condition of the status byte that it receives in the response and therefore only expect a TYPE 6 format message.

It is the responsibility of the customer to define how to deal with any errors indicated within the status byte – the command could be executed again, or the error simply ignored.

Status Code (Hex)	Description	Notes
00h	ок	Command Executed
01h	Unknown Command	The command code is not supported.
02h	Reserved	Reserved for future use.
03h	Out of Range	At least one parameter of the command is out of range.
04h	Reserved	Reserved for future use.
05h	Check error	The command check byte is not consistent with the value indicated by the check byte.
06h – 08h	Reserved	Reserved for future use.

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		NOLOGY	ALC	A T E L	Ĕ	TSUBISHI ECTRIC		OKI	
09h	Command not The module is not able to execute according to current								
	executed conditions.								
0Ah – F	Fh	Reserve	d	Reserved for	future us	e.			
			Table	7 - Error	/ Status	Byte			
	_								
8.3.5.1	Comn	nand Stru	ictures						
A = ackn	owledge	(SDA low)							
Ā = not a	cknowle	dge (SDA H	ligh)						
<u>TYPE 1</u> If the Mas	ster sen	ds a comma	and that i	equires n byte	es of data	to be return	ed:		
							cu .		
Master: Slave:	START	Addr W	A CI	A CF	HK A	STOP			
			Λ	Λ	~				
The Slave	e will ret	urn on recei	ipt of a F	lead Enabled	Address	(Addr R) fron	n the Ma	ster:	
Master:	START	Addr R		A		A	Ā	STOP	
Slave:			A ST	ATUS	DATAn	CHK			
TYPE 2 If the Mas	ster seno		and that i	equires n byte	es of data	to be writter	n to the S	lave:	
Master:	START	Addr W	C	/ID DA	ATAn	CHK	ST	OP	
	START	Addr W	A CI	A DA		CHK	A	OP	
Slave:			A	A		4	A		
Slave: The Slave	e will ret	urn the Stat	A	A only on receip		a ddr R from th	A		
Slave: The Slave Master:			A cus Byte	A only on receip	ot of an A	4	A		
Master: Slave: The Slave Master: Slave:	e will ret	urn the Stat	A cus Byte	A only on receip		a ddr R from th	A		
Slave: The Slave Master: Slave: TYPE 3 { If the Mas	e will ret START	urn the Stat	A Byte A ST Provisior	A only on receip	Ut of an Ad	A ddr R from th	A e Master	:	
Slave: The Slave Master: Slave: TYPE 3 { If the Mas bytes to b Master:	e will ret START	urn the Stat	A ST A ST Provisior and that in the Slave	A A A A A A A A A A A A A A A A A A A	USE} STA	A Image: A mark Iddr R from th Ā STOP Ito be writter CHK	A le Master	: ilave and m	
Slave: The Slave Master: Slave: TYPE 3 { If the Mas bytes to b Master:	e will ret START Not in cu ster send be read l	urn the Stat	A Byte A ST Provisior and that in the Slave	A only on receip	Ut of an Ad CHK Use} es of data	A Image: A form th Ā STOP Image: A form th STOP	A le Master	: ilave and m	
Slave: The Slave Master: Slave: TYPE 3 { If the Mas bytes to b Master: Slave:	e will ret START Not in cu ster send be read l START	urn the Stat	A ST A ST Provision and that i he Slave A Ct	A A A A A A A A A A A A A A A A A A A	USE CHK USE ATA A	A Image: A ddr R from th Ā STOP Image: A Image: A Image: A Image: A Image: CHK A	A le Master	: ilave and m	
Slave: The Slave Master: Slave: TYPE 3 { If the Mas bytes to b Master: Slave:	e will ret START Not in cu ster send be read l START	urn the Stat	A ST A ST Provision and that i he Slave A Ct	A only on receip A A A A A C A C A C A C A A A A A A A	USE CHK USE ATA A	A Image: A ddr R from th Ā STOP Image: A Image: A Image: A Image: A Image: CHK A	A le Master	: ilave and m	
Slave: The Slave Master: Slave: TYPE 3 { If the Mas bytes to b Master: Slave: The Slave	e will ret START Not in cu ster send be read l START e will ret	urn the Stat	A ST A ST Provision and that in the Slave A Cf A ipt of an	A only on receip	USE CHK USE ATA A	A Image: A Image: A Image: A	A le Master	lave and m	
Slave: The Slave Master: Slave: TYPE 3 { If the Mas bytes to b Master: Slave: The Slave Master:	e will ret START Not in cu ster send be read l START e will ret	urn the Stat	A ST A ST Provision and that in the Slave A Cf A ipt of an	A only on receip A A A A A A C A A A A A A A A A A A A	USE} CHK USE} es of data	A ddr R from th A STOP to be writter CHK A r: A	A le Master	lave and m	
Slave: The Slave Master: Slave: TYPE 3 { If the Mas bytes to b Master: Slave: The Slave Master:	e will ret START Not in cu ster send be read I START e will ret	Addr R Addr R Addr R Addr W Addr W Urn on receined Addr R Addr R RENCE DOC	A ST	A only on receip A A A A A A C A A A A A A A A A A A A	Ut of an Ar CHK USE} es of data	A Image: A İdri R from th Ā STOP Ito be writter Image: CHK	A e Master	lave and m	

Master: S Slave: The Slave	START /	Addr W	A	CMD						
						ADDR X		DATA		CHK STC
The Slave			A		A		A		A	A
	will retu	irn the Sta	atus B	yte only	on rec	eipt of a	in Ado	Ir R fror	m the Ma	aster:
Master: Slave:	START	Addr R	А	STATU	A	СНК	Ā	ST	ΟP	
Slave.			А	STATU	5					
Master:	START	Addr W	•	CMD	•	ADDR		СН		STOP
Slave:		<u> </u>	A		A		A	1	A	
The Slave	will retu START	Irn the rec	queste	d byte f	rom Ao		after		in period	l of time:
Slave:		'	А	STATU		DAT		CH		
TYPE 6 If the Mast	ter send	s a comm Addr W	nand o	nly:		СНК		STOP		
Slave:	JIAN	Addifv	Α	CIVID	А	CLIK	A	STOP		
The Slave	will retu	irn the Sta	atus B	yte only	on rec	eipt of a	ın Ado	Ir R fror	m the Ma	aster:
	START	Addr R			Å		À	À S	ГОР	
Slave:			A	STATU	IS	CH				

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<u>8.3.7</u> Mo	odule B	usy			
		-			un el e
an Addr W	(comman	•	and must not be interrupted, and the r d Ā. The master will thus send a STOF message.		
Master: Slave:	START A	.ddr W STO)P		
If the modu	ile is perfo	orming a real-time task,	and must not be interrupted, and the r	master se	nds
			ster will thus send a STOP bit and then	n wait (mir	nimum
		ding the message.	Addrl/M (command) but has not yet	omplotod	l tha
		-	n Addr W (command), but has not yet o nodule will send Ā. The master will thu	-	
bit and the	n wait (mi	nimum 10ms) before re	-sending the message.		
Master: Slave:	START A	ddr R STC			
9 CON	/MAN[D SET DETAILS			
9.1 STA	ATIC DA				
9.1 STA	ATIC DA ata is a ma data store	ATA andatory requirement. ed in memory is listed in	n the table below. The TYPE 1 comm	nand struc	cture is
9.1 STA All static da The static d	ATIC DA ata is a ma data store	ATA andatory requirement. ed in memory is listed in .5.1. Parameter	n the table below. The TYPE 1 comm	nand struc	cture is
9.1 STA All static da The static of shown in se	ATIC DA ata is a ma data store ection 8.3 CMD ¹	ATA andatory requirement. ed in memory is listed in .5.1. Parameter			
9.1 STA All static da The static of shown in se Command Name	ATIC DA ata is a ma data store ection 8.3 CMD ¹ Number	ATA andatory requirement. ed in memory is listed in .5.1. Parameter	Target	Bytes	Туре
9.1 STA All static da The static o shown in se Command Name IND ²	ATIC DA ata is a ma data store ection 8.3 CMD ¹ Number 01h	ATA andatory requirement. ed in memory is listed in .5.1. Parameter Identifiers	TargetType of transceiverNumber of ITU channels (ie 1 for	Bytes 1	Type 1
9.1 STA All static da The static d shown in so Command Name IND ² ITU ³	ATIC DA ata is a ma data store ection 8.3 CMD ¹ Number 01h 02h	ATA andatory requirement. ed in memory is listed in .5.1. Parameter Identifiers Tuning Range	Target Type of transceiver Number of ITU channels (ie 1 for fixed)	Bytes 1 1	Type 1 1
9.1 STA All static da The static d shown in se Command Name IND ² ITU ³ CON ⁴	ATIC DA ata is a ma data store ection 8.3 CMD ¹ Number 01h 02h 03h	ATA andatory requirement. ed in memory is listed in .5.1. Parameter Identifiers Tuning Range Connector	Target Type of transceiver Number of ITU channels (ie 1 for fixed) Code for optical connector type	Bytes 1 1	Type 1 1
9.1 STA All static da The static d shown in se Command Name IND ² ITU ³ CON ⁴ BRN	ATIC DA ata is a ma data store ection 8.3 CMD ¹ Number 01h 02h 03h 04h 05h	ATA andatory requirement. ed in memory is listed in .5.1. Parameter Identifiers Tuning Range Connector Bit Rate, Nominal Length	Target Type of transceiver Number of ITU channels (ie 1 for fixed) Code for optical connector type Nominal bit rate, units of 100Mbps Link length supported for 9/125mm	Bytes 1 1 1 1 1 1 1 1 1	Type 1 1 1 1 1 1

Multi-Source Agreement for DWDM Pluggable Transceiver Modules

Agilent Technologies	Tri
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NEC



VEN⁵	06h	Vendor Name	Module Vendor Name (HEX)	1	1
PPN	07h	Vendor Part Number Leading character first	Product Part No. provided by module vendor (ASCII)	16	1
REV ^B	08h	Vendor Product Release LSB first	Revision level for part (HEX)	2	1
LWA ^C	09h	Wavelength LSB first	Laser Wavelength in tenths pm	4	1
SER	0Ah	Vendor Serial Number Leading character first	Serial number provided by vendor (ASCII)	16	1
DAT ^D	0Bh	Date code LSB first	Vendor's manufacturing date code	4	1
OPT	0Ch	Optional Features	Implemented Optional Features (See Section 9.2)	1	1
Reserved	0Dh - 10h	Reserved	Reserved for future static data	TBD	

1. CMD number is the actual data sent as the 'Command Byte'

2. Type of Transceiver

	01h	Fixed, 100GHz spacing, 2.5Gbps	42h	OC-48 LR-1 SONET (1550nm)
	02h	Fixed, 50GHz spacing, 2.5Gbps	51h	CWDM
	11h	Fixed, 100GHz spacing, 10Gbps	61h	Tx only, fixed, 100Ghzspacing, 2.5Gbps
	12h	Fixed, 50GHz spacing, 10Gbps	62h	Tx only, fixed, 50Ghzspacing, 2.5Gbps
	21h	Tuneable, 100Ghz Spacing, 2.5Gbps	63h	Tx only, fixed, 100Ghz spacing, 10Gbps
	22h	Tuneable, 50Ghz Spacing, 2.5Gbps	64h	Tx only, fixed 50GHz spacing, 10Gbps
	31h	Tuneable, 100Ghz Spacing, 10Gbps	65h	Tx only, Tuneable, 100Ghzspacing, 2.5Gbps
	32h	Tuneable, 50Ghz Spacing, 10Gbps	66h	Tx only, Tuneable, 50Ghzspacing, 2.5Gbps
	41h	OC-48 LR-1 SONET (1310nm)	71h	Rx only
3.	Tuning Ra	ange		
	1 = fixe	n = n channels (i	ie 8 = 8 chanı	nels)
4.	Connecto	r		
	1 = Sin	nplex LC	3 = Sin	nplex MU
	2 = Du	2 = Duplex LC		plex MU
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		kham	OPTOELECTR	ALCAT	EL			OKI
_								
5.	Vendor 01 = Agiler	t Tooba				02 = Bookhan	n Toobhology	
	03 = Triqui		•			04 = Alcatel C		
	05 = Mitsul	-				06 = JDS Uni		
	07 = NEC		5010			08 = OKI		
	09 = Sumit	omo Ele	ctric					
A.	LTH (Link Le	nath in 1	0's km)					
		-		of 10km ur	nits. No decin	nal encodina.		
B.	REV (Revisio	-	-					
		oytes rep	presenting M	ajor and M	inor revision r	numbers. Both	types to use packe	ed BCD, giving revision
	Byte order: N	1inor revi	sion sent firs	st				
C.	LWA (Wavel	ength in	tenths pm)					
	Format: Four band.	bytes ho	olding wavele	ength in pa	cked BCD for	mat. Number	left justified so MS	B holds wavelength
	Example:	1541.7	5					
	Hex:	15	41	75	00			
	Decimal:	21	65	117	00			
	Byte order: L	SB (Unit	s and tenths	of pm) ser	nt first.			
D.	DAT (Date of	manufa	cture)					
	Format: Fou	r bytes h	olding the Ye	ear, Month	and Day in p	acked BCD for	rmat.	
	Example:	31st Ju	ly 2002					
	Hex:	31	07	02	20			
	Decimal:	49	07	02	32			
	Byte order: D	ay sent			year and cen			
			Tab	ole 8 -	Static Dat	a Commar	ia Set	
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		Features as b ount does not in					ure is s	hown ir	n sectior
	-	s a proposal s					hat the	specific	foaturo
		at is not impler			yte. i n			specific	leature
7	6	5	4	3		2	1		0
Reser	ved for fut	ure use	Tone input outpu	/ VOA	V	DT	TUN	1	CDR
		Table 9 -	Optio	nal Comman	d Struct	ure			
9.3 DIA	GNOSTI		RING.						
9.3.1 Liv	ve Data								
All Live Dat									
		datory require		nation 0.2 E	4				
		datory require d structure is s		section 8.3.5.	1.				
The TYPE			hown in s		1. Descriptio	on		Bytes	Туре
The TYPE Command	1 command	Parame	ter	E Signed 2's co	Description	t integ		Bytes 2	Type 1
The TYPE Command Name	1 command CMD Number	Parame Laser Temper LSB and MSB	ter		Descriptio pmplemer Return in	t integ		-	
The TYPE Command Name	1 command CMD Number	Parame	ter	C Signed 2's co temperature.	Description Complemer Return in a degree	t integ		-	
The TYPE Command Name	1 command CMD Number	Parame Laser Temper LSB and MSB LSB First Module Temp	ter rature erature	Signed 2's co temperature. in 1/10ths of (i.e. 345 = 34. Signed 2's co	Description Description Description Description Return in Return in Return in Return in Return i	t integ 16 bit t integ	value er	-	
The TYPE Command Name TEC	1 command CMD Number 11h	Parame Laser Temper LSB and MSB LSB First Module Temp LSB and MSB	ter ature	E Signed 2's co temperature. in 1/10ths of (i.e. 345 = 34.	Description Description Return in a degree 5C) Demplemer Return in	t integ 16 bit t integ	value er	2	1
The TYPE Command Name TEC	1 command CMD Number 11h	Parame Laser Temper LSB and MSB LSB First Module Temp	ter rature	Signed 2's co temperature. in 1/10ths of (i.e. 345 = 34. Signed 2's co temperature.	Description omplemer Return in a degree 5C) omplemer Return in a degree	t integ 16 bit t integ	value er	2	1
The TYPE Command Name TEC	1 command CMD Number 11h	Parame Laser Temper LSB and MSB LSB First Module Temp LSB and MSB LSB First LSB First	ter rature erature	Signed 2's co temperature. in 1/10ths of (i.e. 345 = 34. Signed 2's co temperature. in 1/10ths of (i.e. 345 = 34. Return the la	Description period Return in a degree 5C) perplement Return in a degree 5C) ser bias c	t integ 16 bit t integ 16 bit urrent	value er value in mA.	2	1
The TYPE Command Name TEC TMP	1 command CMD Number 11h 12h	Parame Laser Temper LSB and MSB LSB First Module Temp LSB and MSB LSB First Laser Bias Cu LSB and MSB	ter rature erature	Signed 2's co temperature. in 1/10ths of (i.e. 345 = 34. Signed 2's co temperature. in 1/10ths of (i.e. 345 = 34.	Description period Return in a degree 5C) Return in a degree 5C) ser bias co period as a	t integ 16 bit t integ 16 bit urrent n unsig	value er value in mA.	2	1
The TYPE Command Name TEC TMP BIA	1 command CMD Number 11h 12h 13h	Parame Laser Temper LSB and MSB LSB First Module Temp LSB and MSB LSB First Laser Bias Cu LSB and MSB LSB First	ter ature erature	Signed 2's co temperature. in 1/10ths of (i.e. 345 = 34. Signed 2's co temperature. in 1/10ths of (i.e. 345 = 34. Return the la Result is retu bit value in 1.	Description omplemer Return in a degree 5C) omplemer Return in a degree 5C) ser bias co irrned as a /10ths of a	t integ 16 bit t integ 16 bit urrent n unsig a mA.	value er value in mA. gned 16	2 2 2 2 2	1 1 1 1
The TYPE Command Name TEC TMP	1 command CMD Number 11h 12h	Parame Laser Temper LSB and MSB LSB First Module Temp LSB and MSB LSB First Laser Bias Cu LSB and MSB	ter rature erature	Signed 2's co temperature. in 1/10ths of (i.e. 345 = 34. Signed 2's co temperature. in 1/10ths of (i.e. 345 = 34. Return the la Result is retu	Description omplemer Return in a degree 5C) omplemer Return in a degree 5C) ser bias c urned as a (10ths of a ser mod c	t integ 16 bit t integ 16 bit urrent n unsig a mA.	value er value in mA. gned 16 in mA.	2	1
The TYPE Command Name TEC TMP BIA	1 command CMD Number 11h 12h 12h 13h	Parame Laser Temper LSB and MSB LSB First Module Temp LSB and MSB LSB First Laser Bias Cu LSB and MSB LSB First Laser Mod Cu LSB and MSB	hown in s	Signed 2's co temperature. in 1/10ths of (i.e. 345 = 34. Signed 2's co temperature. in 1/10ths of (i.e. 345 = 34. Return the la Result is retu bit value in 1. Return the la Result is retu	Description omplemer Return in a degree 5C) omplemer Return in a degree 5C) ser bias c irned as a (10ths of a ser mod c irned as a	t integ 16 bit t integ 16 bit urrent n unsig a mA. current n unsig	value er value in mA. gned 16 in mA. gned 16	2 2 2 2 2 2 2 2	1 1 1 1
The TYPE Command Name TEC TMP BIA	1 command CMD Number 11h 12h 12h 13h	Parame Laser Temper LSB and MSB LSB First Module Temp LSB and MSB LSB First Laser Bias Cu LSB and MSB LSB First Laser Mod Cu LSB and MSB	ter rature erature rature	Signed 2's co temperature. in 1/10ths of (i.e. 345 = 34. Signed 2's co temperature. in 1/10ths of (i.e. 345 = 34. Return the la Result is retu bit value in 1/ Return the la Result is retu DIM PLUGGA allowed to this	Description omplemer Return in a degree 5C) omplemer Return in a degree 5C) ser bias c irned as a /10ths of a ser mod c irned as a BLE TRAN documen	t integ 16 bit 16 bit 16 bit 16 bit urrent n unsig a mA. current n unsig	value er value in mA. gned 16 in mA. gned 16 ER MOD	2 2 2 2 2 2 2 2	1 1 1 1

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X	Agilent Technologies Bookham Technology			JDS Uniphase NEC	¢ SUMIT	iomo electri(
				bit value in 1/10ths of a mA.		
			LSB First			
	POT ¹	15h	TX Power LSB and MSB LSB First	Return measured TX output power in μW. Represented as an un-signed 16 bit integer in μW.	2	1
	POR ¹	16h	RX Power LSB and MSB LSB First	Return measured RX input power in μW. Represented as an un-signed 16 bit integer in 1/10's of a μW.	2	1
	APV	17h	APD Voltage supply LSB and MSB LSB First	Return measured APD supply voltage. Represented as an unsigned 16 bit integer in 1/10ths of a Volt	2	1
	Reserved	18h - 1Ch	Reserved	Reserved for future live data	tbd	

1. The required resolution is not an indicator of the required accuracy

Table 10 Live Data Command Set

9.3.2 Transceiver Status

The STA command (1Dh) is a TYPE 1 command, and will return the 1-byte status of the Transceiver as below. The TYPE 1 command structure is shown in section 8.3.5.1.

7	6	5	4	3	2	1	0
Laser Status	Alarm Triggered	Warning Triggered	Module Disabled	Ve	ndor Speci	fic Status E	Bits

Bit Set = Flag Triggered

Bit Clear = Module OK, no Alarms or Warnings triggered

Table 11 - Status Command Structure

Laser Status is indicated by a 1 = Operating (presence of light), and 0 = Disabled (no light).

'Alarm Triggered' is flagged by any of the alarms in section 9.3.1, and 'Warning Triggered is flagged by any of the un-masked warnings in section 9.3.3.

Module disabled is the inverted logic value of the hardware pin 'Module Enable' and is used to indicate the module status Disabled/Enabled.

The vendor specific status bits will be defined through a vendor specific table.

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9.4 ALARMS AND WARNINGS

Tx_ALARM (or Rx_ALARM) hardware pins are to be used as an interrupt if either the alarm or warning flags indicate an event occurred. The pins will also be asserted when Module Enable is de-asserted.

The customer will reset the alarms by sending the reset commands 'RST and/or RSR' – see Section 9.4:-Control Functions.

9.4.1 Alarms (All Alarms are a mandatory requirement)

Alarm flags indicate conditions likely to result (or have resulted) in module failure or out of specification operation and indicate cause for immediate investigation. These events are non-mask-able, and any alarm that occurs will result in TX and/or RX being shut down.

Command Name	CMD	Bit	Name	Description	Action	Туре		
		7	Module Temp High Alarm	Set when module temperature exceeds high alarm level	Shut down TX and RX	1		
		6	Module Temp Low Alarm	Set when module temperature is below low alarm level	Shut down TX and RX	1		
		5	Wavelength Maximum	Set when wavelength exceeds high alarm level	Shut down TX only	1		
ALA				4	Wavelength Minimum	Set when wavelength is below low alarm level	Shut down TX only	1
(1Byte)	1Eh	3	Tx Power High Alarm	Set when Tx Output power exceeds high alarm level	Shut down TX only	1		
		2	Tx Power Low Alarm	Set when Tx Output Power is below low alarm level	Shut down TX only	1		
				1	APD Bias Voltage	Set when APD Voltage exceeds high Alarm level	Shut down RX only	1
		0 ¹	Module Time Out	Set when the module does not reach full operating status within a set start-up time	Shut down TX only	1		

1. Module time out is TX dependant failure during start-up, also asserting the TX Alarm. RX failure during start-up will assert the Rx Alarm only.

The TYPE 1 command structure is shown in section 8.3.5.1.

Table 12 - Alarm Flag Structure

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9.4.2 Alarm Trip Points

The activation of an alarm will indicate to the user that a major malfunction or out of tolerance condition has occurred.

This condition will affect traffic through part of the module, could affect other channels or lead to damage to the module.

When an alarm is detected the module will shutdown itself (Tx and/or Rx in function of which alarm was detected) to prevent further damage and to prevent any possible impact to traffic on other channels. If a Module Temp High or Module Temp Low occur the module will be shut down (both Tx and Rx) and to reset the module the customer must send both RST and RSR.

During warm-up, specific alarm activation is disabled, with the exception of Module time-out, Module Temp High and Module Temp Low.

ALA 07	Module Temp High	TMPmax +5% of TMPmax - TMPmin
ALA 06	Module Temp Low	TMPmin -5% of TMPmax - TMPmin
ALA 05	Wavelength High	+ channel spacing/2
ALA 04	Wavelength Low	- channel spacing/2
ALA 03	Tx Power High	POTnom +50%
ALA 02	Tx Power Low	POTnom -50%
ALA 01	APD Voltage High	APVmax +15%
ALA 00	Start Up Time Out	Start-up Time (Controlled) + 10 seconds

Note:- The values in this table are for guidance purposes only. The vendor determines alarm level trip points.

Table 13 - Normalised Alarm Activation Levels

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9.4.3 Warnings (All Warnings are a mandatory requirement)

Warning flags generally can be used to indicate end of life conditions (such as for higher than expected bias currents in a constant power control loop). These events will assert the relevant hardware alarm, but are mask-able pending host controller intervention. Masking will de-assert the relevant hardware alarm. If the reason for the warning goes away, the warning should be de-asserted automatically at both hardware and software levels, without the host having to mask the warning. The warning masks are set at 1 (all enabled) by default. The default value will be loaded when a TX or RX reset command occurs.

Command Name	CMD	Bit	Name	Description	Туре
		7	LD Current Warning High	Set when Ibias or Imod exceeds max warning level	1
		6	Module Temp High Warning	Set when module temp exceeds max warning level	1
	1Fh	5	Module Temp Low Warning	Set when module temp exceeds min warning level	1
WAA		4	TEC Current warning maximum	Set when TEC Current exceeds max warning level	1
		3	Rx Optical Power High Warning	Set when Received Power exceeds high warning level	1
		2	LOS	Loss Of Signal	1
		1	LOL	Loss Of Lock (CDR Variant Only)	1
		0	Wavelength Warning	Set when wavelength drift exceeds vendor specific limit	1

The TYPE 1 command structure is shown in section 8.3.5.1.

Table 14 - Warning Flag Structure

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Multi-Source Agreement for DWDM Pluggable Transceiver Modules SUMITOMO ELECTRIC Agilent Technologies TriQuint 🌘 NEC **IDS** Uniphase **OPTOELECTRONICS** MITSUBISHI oki ALCATEL Command CMD Function **Bytes** Type Name Sets the Masking byte for the warnings. The masking byte will be ANDed with the warning byte to define which warning will MAS 20h trigger Tx_ALARM or Rx_ALARM. Mask corresponds to the bit 1 2 numbers in command WAA. Use 1 to define warning triggered, 0 to define warning ignored. MAR 21h Reads the Masking byte for warnings 1 1

TYPE 1 and TYPE 2 command structures are shown in section 8.3.5.1.

Table 15 - Warning Flag Masking byte

9.4.4 Warning Trip Points

The activation of a warning will indicate to the user that the module is approaching an out of range condition on a parameter(s).

Should this out of range actually occur, an Alarm condition may result, traffic may be affected or the module will fail to meet its performance requirements.

A warning condition will not affect the modules ability to meet its performance requirements and can be software masked.

WAA 07	LD Current High	>= BIAmax - 25% or MODset +20%		
WAA 06	Module Temp High	>= TMPmax - 5% of TMPmax-TMPmin		
WAA 05	Module Temp Low	<= TMPmin +5% of TMPmax-TMPmin		
WAA 04	TEC Current High	>= Itecmax -5%		
WAA 03	Rx Power High	>= PORmax -5%		
WAA 02	Loss Of Signal	Loss Of Signal		
WAA 01	Loss Of Lock (CDR variant only)	Loss of CDR Lock		
WAA 00	Wavelength Warning	>< Normal wavelength Range		

Note:- The values in this table are for guidance purposes only. The vendor determines warning level trip points.

Table 16 - Normalised Warnings

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					♦ SUMITO Diki		
<u>9.5</u> CO		UNCTIONS					
These com	nmands pe	erform basic control	functions required d	luring set up of the	module	by the	
	-		command structures	•		-	
Command Name	CMD Number	Parameter	Function	Operand	Bytes	Туре	
		Set Operating State	Sets the current	00h = Transmitter			
CHN⁴	22h		operating channel, or disables optical	Disabled	1	2	
			output	01h = Channel 1			
CHR⁵	23h	Read Operating state	Reads the current	Command Only	1	1	
CHK			operating channel set by CHN				
	24h	Set Default Power On State	Sets the default	00h = Transmitter			
DEF ⁸			power on state of	Disabled	1	2	
			the module	01h = Channel 1			
DED ⁵	25h	Read Default Power On State	Reads the default	Command Only		1	
DER⁵			power on state of the module		1	1	
	26h	Set Wavelength Fine Adjustment State	Set Fine adjustment of wavelength	Signed 2's complement digital number.			
TUN ³					1	2	
	27h	Read Wavelength Fine Adjustment	Reads Fine	Command Only			
TUR⁵					1	1	
		State	wavelength		<u> </u>	<u> </u>	
SOP ⁸	28h	Store Wavelength Operating Point	Store new wavelength operating point	Command Only	0	6	
SOP						0	
RST ¹	29h	Resets TX	Resets TX	Command Only	0	6	
RSR ²	2Ah	Resets RX	Resets RX	Command Only	0	6	
ROP⁵	2Bh	Read Stored	Reads wavelength				
		Wavelength Operating Point	operating point	Command Only	1	1	
		Set Variable	Sets Variable				
VTH ^{4,9}	2Ch	Threshold	Threshold Level	Signed Number	2	2	
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		OPTOELECTRONICS					
RTH⁵ 2Dh STH ⁶ 2Eh		Read Variable Threshold	Reads Variable Threshold point	Signed Number	2	1	
		Store Current Threshold Value	Stores Current Threshold Value	Command Only	0	6	
RTHNV⁵	2Fh	Read stored Threshold value	Reads stored Threshold value	Signed Number	2	1	
RTHEN ⁷ 30h VOA ⁴ 31h		Enable / Disable Variable Threshold	Enables / Disables Variable Threshold	Unsigned Byte	1	2	
		Set Variable Optical Attenuation	Sets Optical Attenuation adjustment	Unsigned Number	2	2	
ROA⁵	32h	Read Optical Attenuation Adjust	Reads Optical Attenuation adjustment	Unsigned Number	2	1	
SOA ⁸	33h	Store Current Optical Attenuation value	Stores Current Optical Attenuation value	Command Only	0	6	
ROANV⁵	34h	Read Stored Optical Attenuation value	Reads Stored Optical Attenuation value	Unsigned Number	2	1	
Reserved	35h-3Fh	Reserved	Reserved for future control functions	Reserved	TBD	TBD	
Reserved	60h-	Reserved	Reserved for factory calibration	Factory Use	TBD	TBD	

1. Clears hardware Tx Alarm, restores defaults using last wavelength stored via the SOP command, restores warning mask default and restarts transmitter.

2. Clears hardware Rx Alarm, restores defaults, restores warning mask default and restarts receiver.

3. The TUN command allows the wavelength to be increased or decreased. The actual wavelength change will be module and supplier specific.

- 4. The value is used and stored in volatile memory
- 5. The value is used and read from volatile memory
- 6. The value is stored in non-volatile memory. This value is loaded from non-volatile memory on power up or when a RSR command occurs.
- 7. Value of 0 disables Variable Threshold. Module powers up in nominal threshold (50%) state. The value set through the Threshold Commands has no effect on the crossing voltage until enabled.
- 8. The value is stored in non-volatile memory. This value is loaded from non-volatile memory on power up or when a RST command occurs
- 9. A threshold value of zero indicates that the crossing is at the factory default setting. Threshold values less / greater than zero shift the threshold voltage down / up.

Table 17 - Control Functions Structure

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9.6 CUSTOMER FUNCTIONS

At least 32 bytes of memory have been reserved for customer requirements.

The customer will be able to write to and read from the reserved area of the non-volatile memory for customer use on a byte by byte basis

Command	CMD Number		Parameter Data		Туре
WRI ¹	40h	Customer Memory Write	Customer can write data to the memory locations reserved for customer use.	1 byte at a time	4
REA ²	41h	Customer Memory Read	Customer can read data from the memory locations reserved for customer use.	1 byte at a time	5
Reserved	42h - 4Fh	Reserved	Reserved for future customer functions	TBD	TBD

1. A TYPE 4 command structure (see section 8.3.5.1) is utilised in order to allow single byte writes to the reserved area of the memory for customer use.

2. A TYPE 5 command structure (see section 8.3.5.1) is utilised in order to allow single byte reads from the reserved area of the memory for customer use.

Table 18 - Customer Memory Functions

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The modulation input allows amplitude modulation of the "1"s level in the frequency range of 50 - 500 KHz. This input must be driven from a 50 Ohm source, and is AC coupled internally. Do not exceed the maximum drive level, over driving this input can cause waveform distortion. If unused this input should be connected to 0V to prevent noise pickup. The output is AC coupled and dependant on received power and modulation depth.

11 POWER SUPPLY REQUIREMENTS

The module requires a single supply of +3.3V \pm 5%.

Parameter	Min	Nom	Мах	Units
Vcc Supply	3.135	3.3	3.465	v
Power Consumption			7	w

1. Maximum continuous current is limited by the connector rating.

Table 19 -	Power Supply Requirements
------------	---------------------------

Supply Rail	Мах	Units	Conditions
Vcc Supply Noise	50	mVpp	6kHz – 1MHz

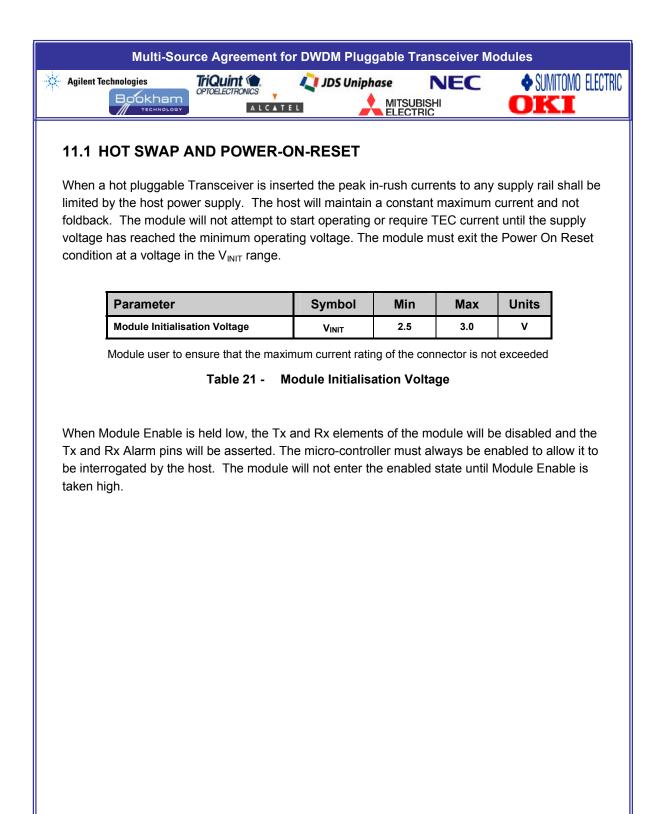
Table 20 - Power Supply Noise Requirements

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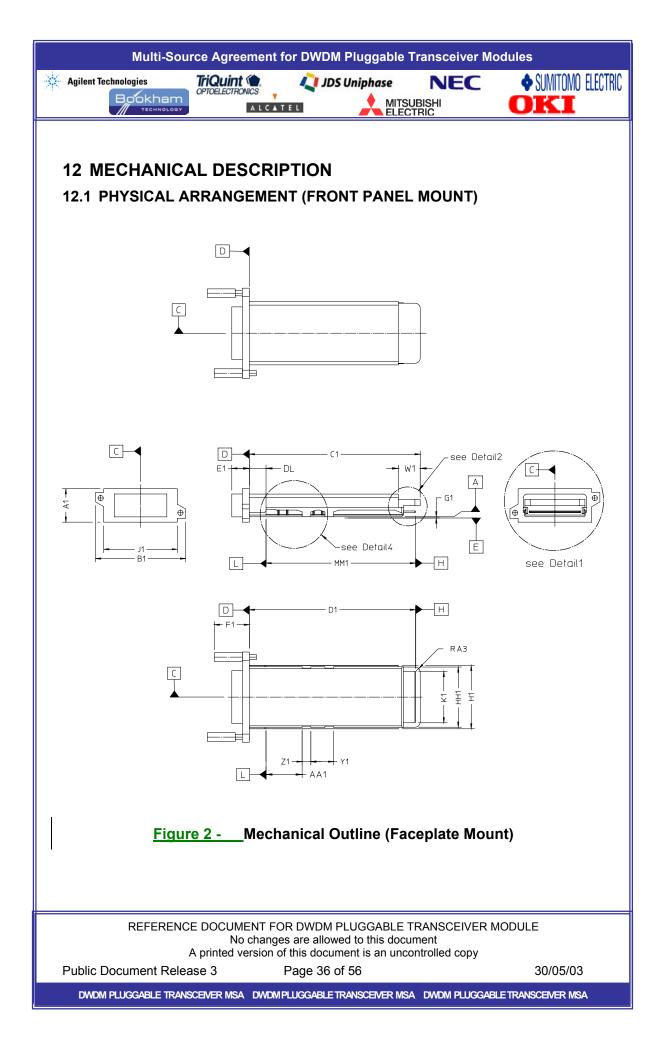


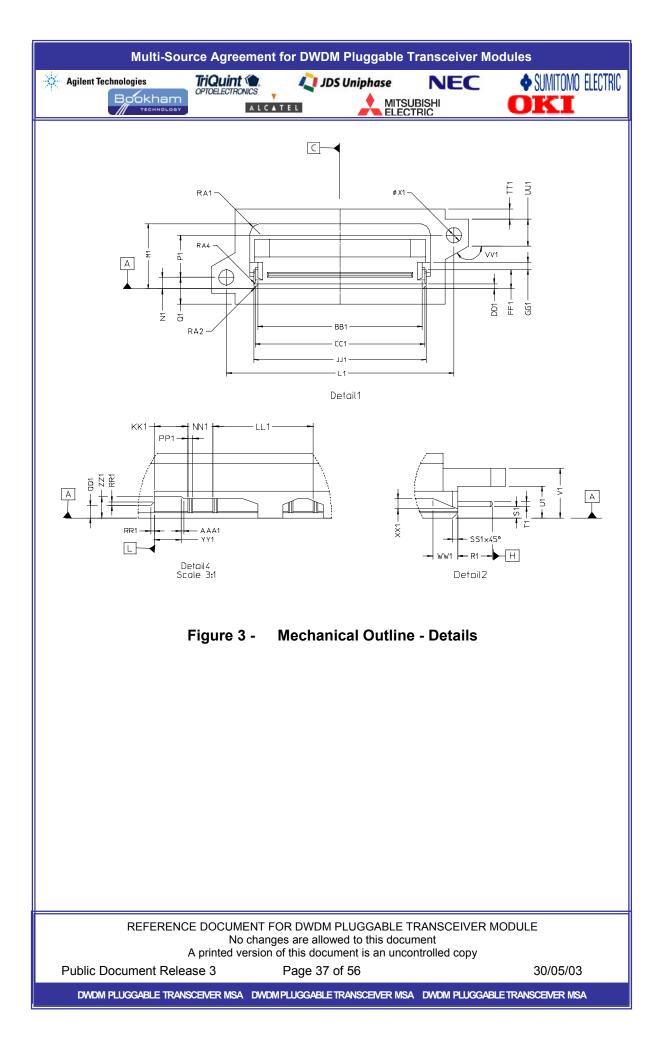
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KEY	VALUE (mm)	TOLERANCE (mm)	COMMENT	
A1	19.0	+/- 0.1	Height of bezel overall	
B1	51.3	+/- 0.2	Width of bezel overall	
C1	97.5	REF	Length of transceiver body from datum D to end of rear shoulder	
D1	94.8	+/- 0.3	Datum D to datum H	
DL	9.5	+/- 0.3	Datum D to datum L	
E1	10.0	Мах	Datum D to front of module body, in-board as well as front-panel mount options	
F1	20.0	Max	Datum D to end of captive thumb screws	
G1	0.5	N/A	Vertical stand-off of transceiver body from host circuit card	
H1	36.0	+/- 0.15	Width of transceiver body, overall width of in-board mount transceiver	
J1	42.0	+/- 0.2	Width of bezel without side flanges	
K1	29.2	Ref.	Width of transceiver circuit card	
L1	45.5	+/- 0.2	Distance between holes for captive thumb screw centres in 'X' axis	
M1	12.9	+0.0 - 0.3	Height of transceiver body, overall height of in-board mount transceiver	
N1	2.25	+/- 0.3	Vertical distance from datum A to bottom hole for captive thumb screw centre	
P1	8.4	+/- 0.1	Vertical distance between holes for captive thumb screw centres	
Q1	5.3	+/- 0.1	Vertical distance from bottom of bezel to hole for captive screw	
R1	6.9	+/- 0.2	Datum H to end of recess for electrical edge connector	
S1	2.3	+/- 0.15	Datum A to bottom of transceiver PCB	
T1	1.0	Ref.	Transceiver PCB thickness	
U1	6.3	Min	Datum A to underside of rear shoulder	
V1	9.85	+/- 0.2	Height of rear shoulder from Datum A	
W1	12.5	Min	Length of rear shoulder	
X1	N/A	N/A	Holes for M3 captive thumb screws	
Y1	13.0	+/- 0.2	Pitch of vertical slots for plugging	
Z1	5.0	+/- 0.2	Width of vertical slots for plugging	
AA1	20.6	+/- 0.2	Datum L to first vertical slot for plugging	
BB1	33.0	+/- 0.2	Width of module slot to accommodate rail	
CC1	34.0	+/- 0.2	Width of module slot to accommodate location features on rail	
DD1	1.0	+/- 0.15	Datum A to base of module slot to accommodate location features on rail	
FF1	3.8	+/- 0.15	Datum A to base of module slot to accommodate rail	
GG1	1.5	+/- 0.2	Height of module slot to accommodate rail	

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;							
	HH1	34.2	+/- 0.2	Width of PCB rear shoulder			
	JJ1	34.6	+/- 0.2	Outer width of module slot to accommodate rail			
	KK1	6.6	+/- 0.2	Datum L to first rail location feature			
	LL1	20.0	+/- 0.2	Pitch of rail location features			
	MM1	85.3	+/- 0.2	Datum H to Datum L			
	NN1	5.0	+/- 0.2	Pitch of rail location features			
	PP1	1.0	+/- 0.2	Width of rail location features			
	QQ1	2.5	+/- 0.15	Datum A to bottom of hard stop			
	RR1	0.75	+/- 0.1	Depth of chamfer on hard stop			
	SS1	1.0	+/- 0.1	Size of chamfer on bottom corner of module adjacent to electrical connector			
	TT1	2.1	+/- 0.2	Top of side flange to top of bezel			
	UU1	5.4	+/- 0.2	Outer height of side flange			
	VV1	150°	+/- 1°	Angle of chamfer on side flange			
	WW1	5.0	+/- 0.5	Length of chamfer into slot for rail			
	XX1	2.0	+/- 0.5	Height of chamfer into slot for rail			
	YY1	5.25	+/- 0.1	Datum L to chamfer on vertical location feature			
	ZZ1	4.2	+/- 0.1	Datum A to vertical location feature			
	AAA1	0.6	+/- 0.1	Depth of chamfer on vertical location feature			
	RA1	2.0	Min	External radius or chamfer on transceiver lid			
	RA2	1.0	Min	External radius or chamfer on transceiver base			
	RA3	3.0	+/- 0.5	External radius on rear shoulder			
	RA4	0.3	Ref.	Internal radius on module slot to accommodate location features on rail			

N.B. For in-board mount option please refer to dimensions E1, H1 and M1.

Table 22 Definition of Transceiver Module Dimensions

DATUM	DESCRIPTION
Α	BOTTOM SURFACE OF TRANSCEIVER BODY
С	CENTRAL VERTICAL PLANE OF TRANSCEIVER BODY
D	BACK SURFACE OF MODULE BEZEL, SAFETY HARD STOP
E	TOP SURFACE OF HOST PCB
Н	BACK FACE OF TRANSCEIVER PCB
L	VERTICAL FACE OF MODULE HARD STOP, HARD STOP ON RAIL

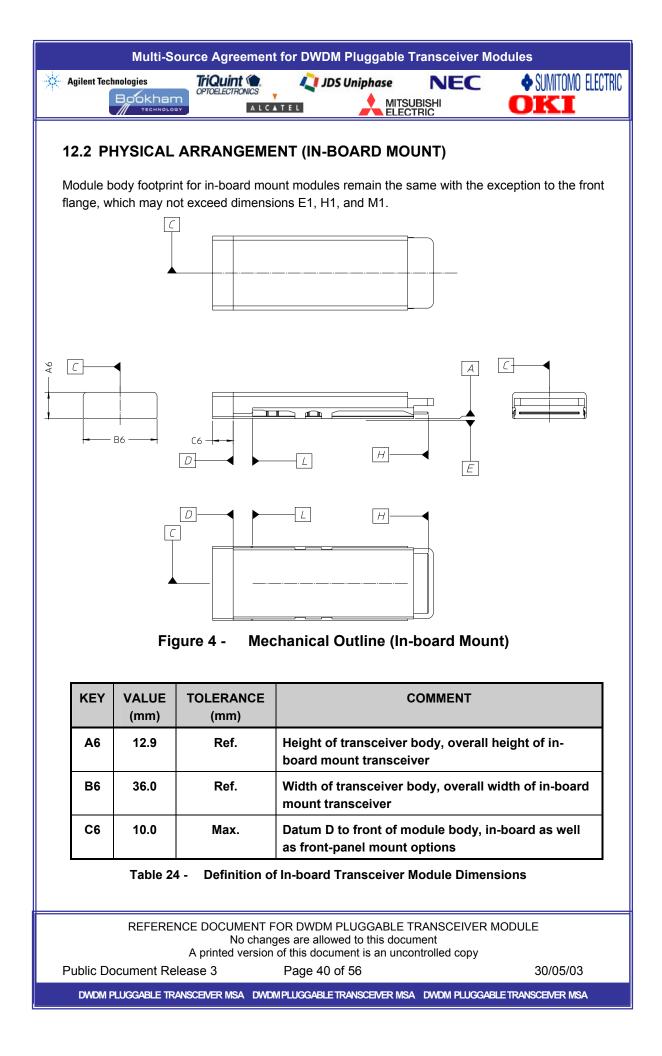
 Table 23 Definition of Transceiver Module Datums

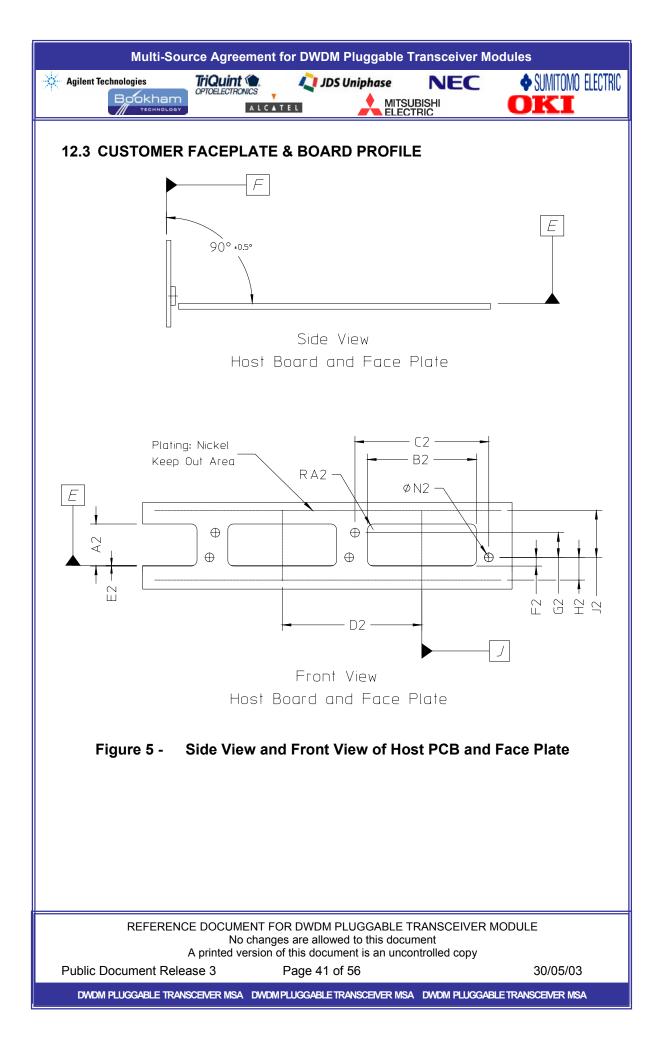
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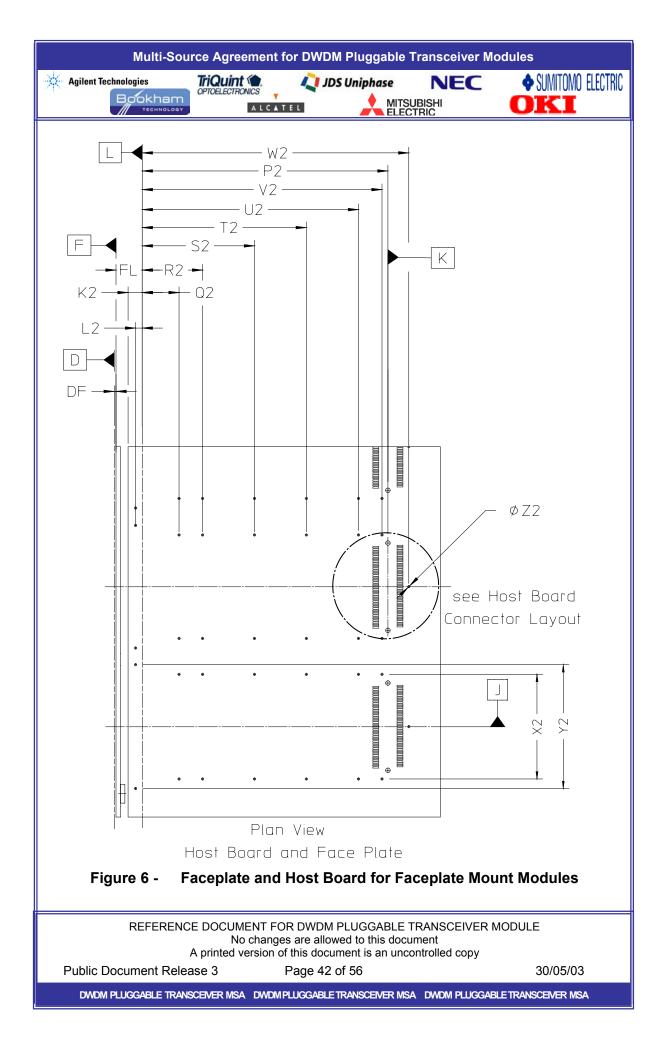
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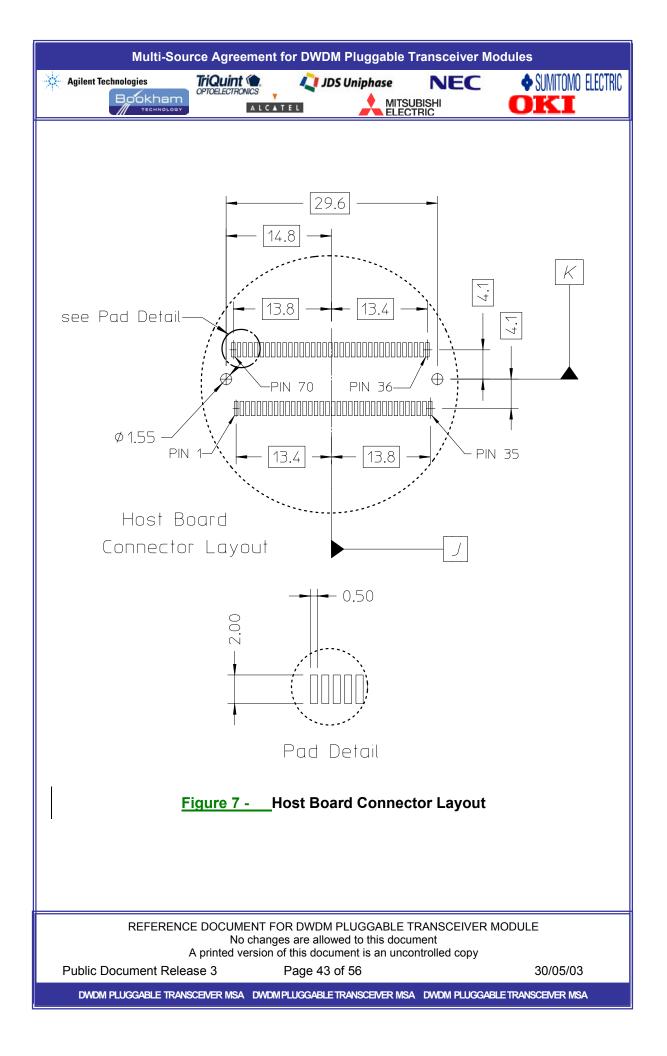
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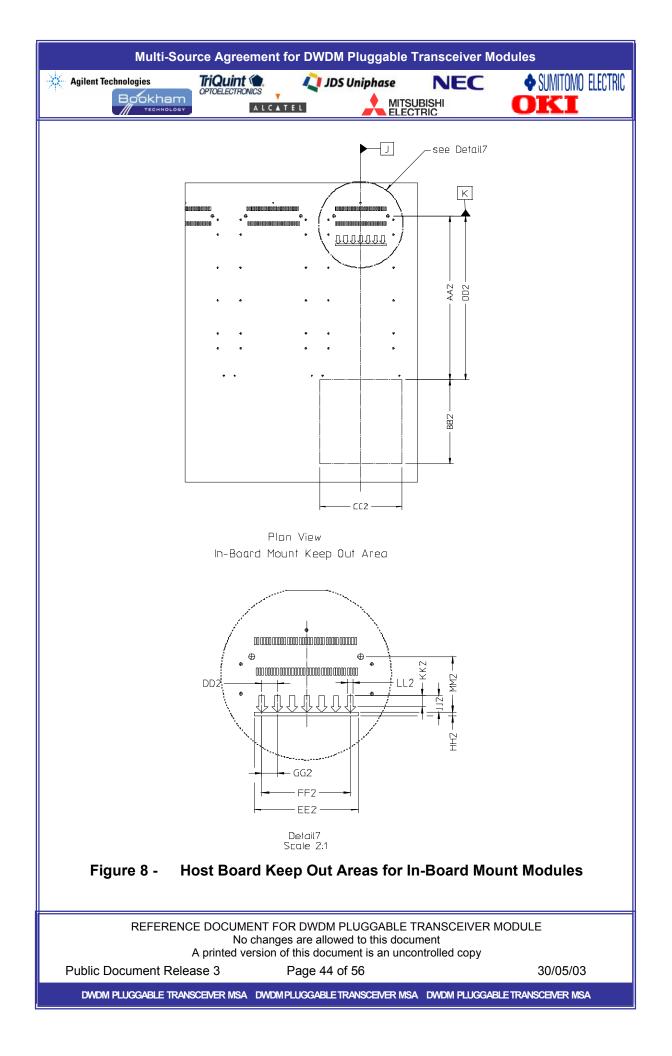
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KEY	VALUE	TOLERANCE	COMMENTS	
	(mm)	(mm)	COMMENTS	
A2	14.3	+/- 0.15	Cut-out in host face plate, 'Y' axis	
B2	37.0	+/- 0.15	Cut-out in host face plate, 'X' axis	
C2	45.5	+/- 0.2	Distance between mounting holes for captive thumb screws, 'X' axis	
D2	47.47	Min	Distance between adjacent transceiver modules	
E2	0.2	+/- 0.3	Datum E to bottom of cut-out in host face plate	
F2	2.95	+/- 0.15	Lower mounting hole to bottom of cut-out in host face plate	
G2	8.4	+/- 0.15	Distance between mounting holes for captive thumb screws, 'Y' axis	
H2	6.3	Min	Distance between lower mounting hole and bottom of keep out on host face plate, 'Y' axis	
J2	14.7	Min	Distance between lower mounting hole and top of keep out on host face plate, 'Y' axis	
K2	4.8	+/- 0.2	Datum L to front edge host PCB edge	
L2	2.25	+/- 0.2	Datum L to first plated through holes on host PCB for rail	
N2	M3	0.2 Positional	Hole tapped for M3 captive screws	
P2	83.4	+/- 0.2	Datum L to Datum K	
Q2	12.5	+/- 0.2	Datum L to second plated through holes in host PCB for rail	
R2	20.5	+/- 0.2	Datum L to third plated through holes in host PCB for rail	
S2	38.1	+/- 0.2	Datum L to fourth plated through holes in host PCB for rail	
T2	55.7	+/- 0.2	Datum L to fifth plated through holes in host PCB for rail	
U2	73.4	+/- 0.2	Datum L to sixth plated through holes in host PCB for rail	
V2	81.4	+/- 0.2	Datum L to seventh plated through holes in host PCB for rail	
W2	90.5	+/- 0.2	Datum L to eighth plated through hole in host PCB for rail	
X2	35.5	+0, -0.2	Distance between inner mount holes for rail, 'X' axis	
Y2	42.0	+0, -0.2	Distance between outer mount holes for rail, 'X' axis	
Z2	0.8	+0.1 / -0	Diameter of plated through holes for rail	
AA2	87.9	+/- 0.5	Datum K to inner edge of keep out area for in-board mount option	
BB2	45.0	+/- 0.5	Depth of keep out area for in-board option	
CC2	45.0	+/- 0.5	Width of keep out area for in-board option	
EE2	28.2	+/- 0.2	Width of reference stop line of host card PCB for in-board mount	
FF2	24.0	+/- 0.2	6 pitches of GG2	
GG2	4.0	+/- 0.2	Individual pitch between arrow	
HH2	0.9	+/- 0.2	Length of reference stop line of host card PCB for in-board mount	
JJ2	4.6	+/- 0.2	Overall length of arrow	
KK2	3.0	+/- 0.2	Length of arrow	
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	LL2	1.5	+/- 0.	.2 Width of	farrow			
	MM2	15	+/- 0.	.2 Location in-board	n position of referend I mount	ce stop line of h	ost card PCB for	
	RA2	2.0	Max	d Internal	radii for cut-out in he	ost face plate		

Table 25 - Definition of Host Card / Face Plate Dimensions

DATUM	DESCRIPTION			
E	Fop surface of host PCB			
F	Front surface of host face plate			
J	Centre vertical plane of rail system			
L	Vertical face of module hard-stop, hard-stop on rail.			
к	Centre of 70 way edge connector mounting holes			

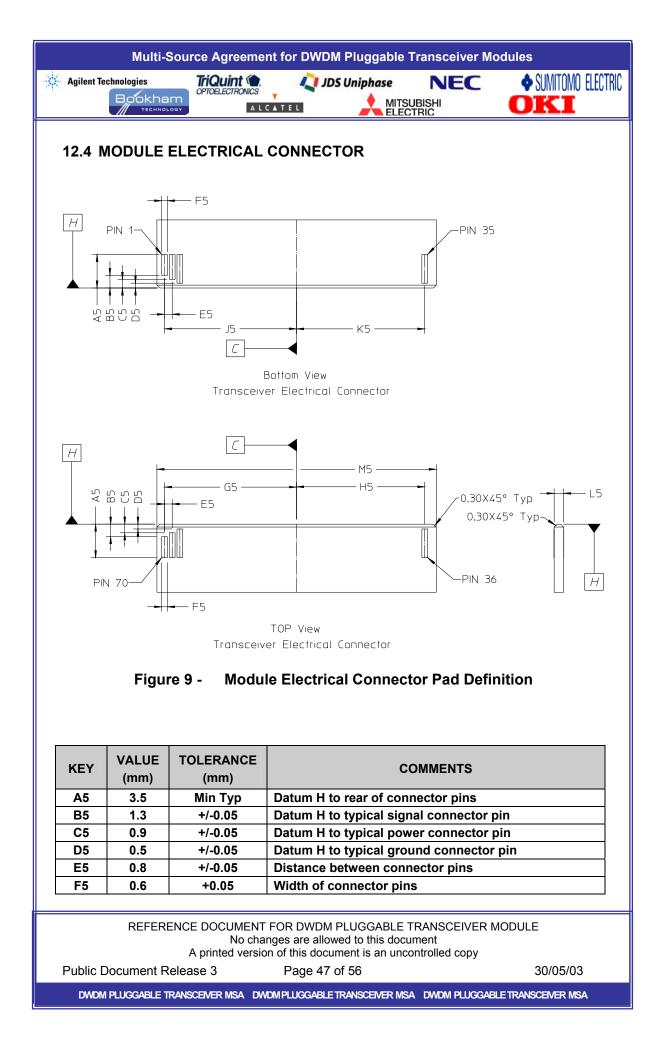
Table 26 - Definition of Host Card / Face Plate Datums

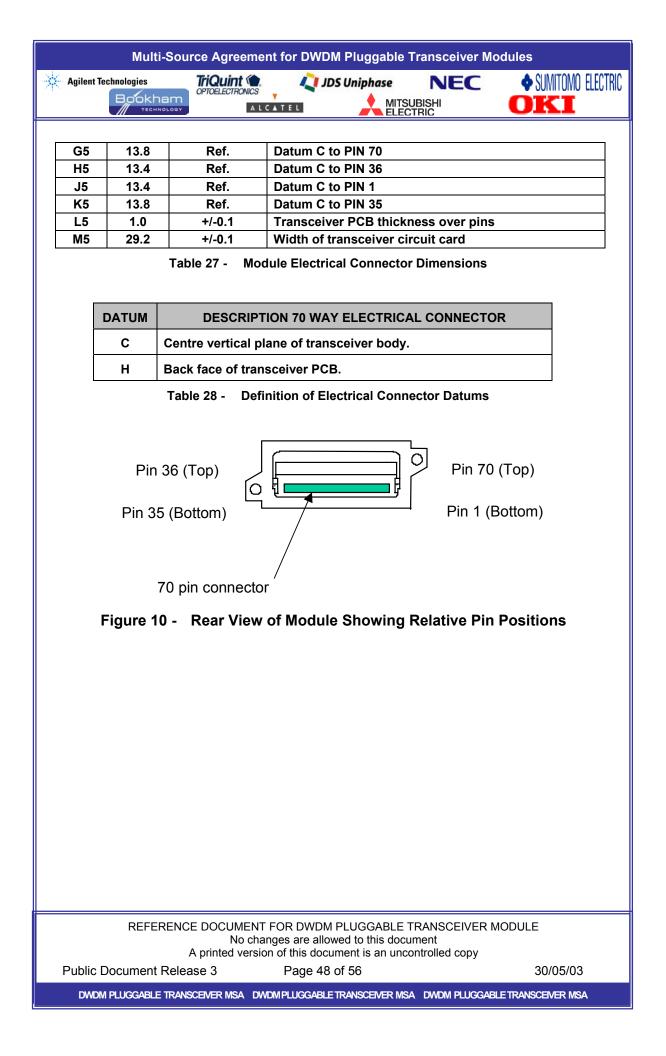
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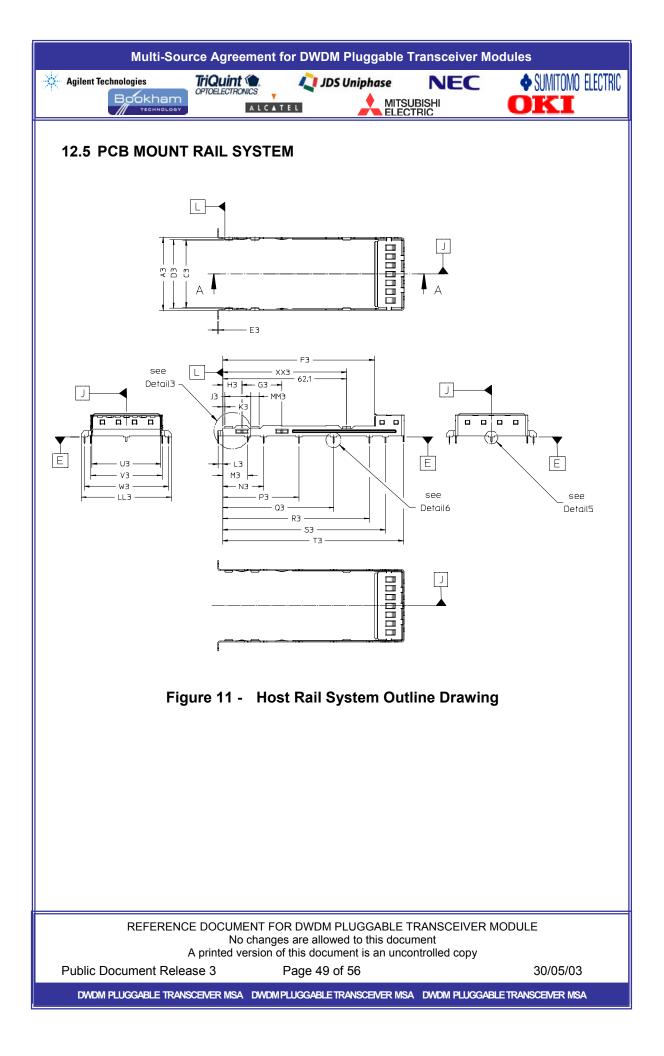
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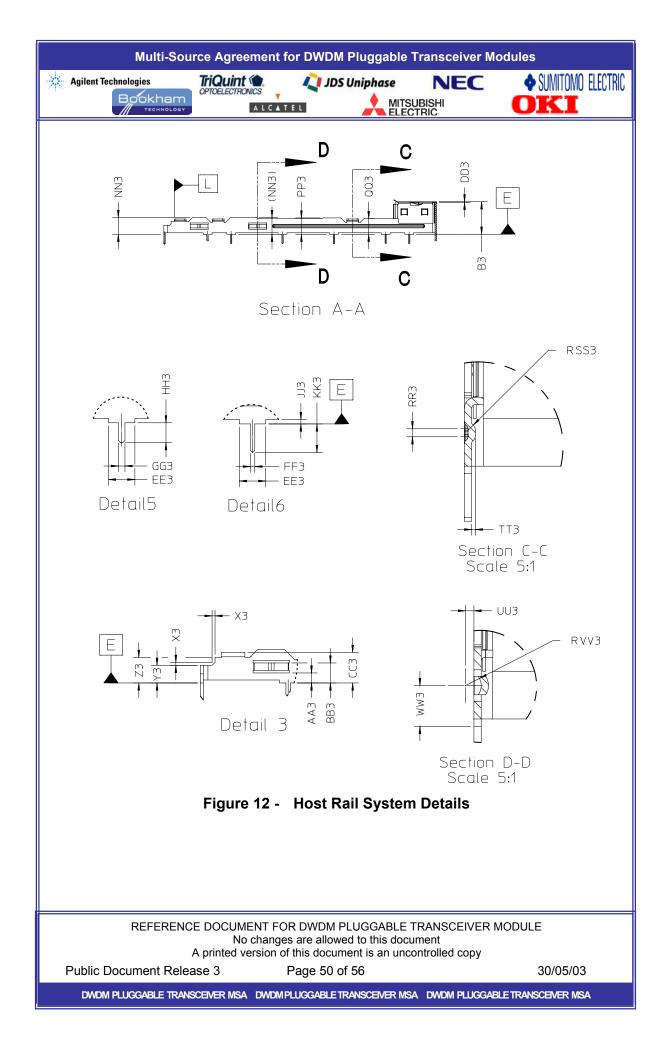
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NEC



KEY	VALUE (mm)	TOLERANCE (mm)	COMMENTS	
A3	36.0	+0 / -0.2	Overall width of body of rail system.	
B3	11.05	+/-0.2	Datum E to top of rail system	
C3	33.4	+/-0.2	Internal width of rail system at guide features	
D3	34.0	+0.3 / -0	Internal width of rail system at location features	
E3	0.5	+/-0.01	Material thickness of body of rail system	
F3	76.0	+/-0.2	Datum L to beginning of EMI shield to accommoda transceiver rear shoulder	
G3	20.0	+/-0.15	Pitch of location features	
H3	9.6	+/-0.15	Datum L to centre of first location feature	
J3	13.0	+/-0.15	Pitch of guide features	
K3	1.1	+/-0.1	Datum L to first guide feature	
L3	2.25	+/-0.2	Datum L to first solder pin	
M3	12.5	+/-0.2	Datum L to second solder pin	
N3	20.5	+/-0.2	Datum L to third solder pin	
P3	38.1	+/-0.2	Datum L to fourth solder pin	
Q3	55.7	+/-0.2	Datum L to fifth solder pin	
R3	73.4	+/-0.2	Datum L to sixth solder pin	
S3	81.4	+/-0.2	Datum L to seventh solder pin	
Т3	90.5	+/-0.2	Datum L to eighth solder pin	
U3	34.4	REF	Internal width of rail system at EMI shield	
V3	35.5	+0 / -0.2	Distance between centres of inner solder pins, 'X' Axis	
W3	42.0	+0 / -0.2	Distance between centres of outer solder pins, 'X' Axis	
X3	0.5 Max	+0 / -0.05	Height and length of chamfer at base of hard stop	
Y3	3.0	+/-0.05	Datum E to base of hard stop	
Z3	4.35	+/-0.1	Datum E to top of hard stop	
AA3	1.7	+/-0.1	Datum E to base of location features	
BB3	3.4	+/-0.1	Datum E to top of location features	
CC3	5.2	+/-0.1	Datum E to top of guide features	
DD3	0.2	+/01	Material thickness of EMI shield	
EE3	3.0	+/-0.2	Width of board stand-off at solder pins	
FF3	0.5	+/-0.05	Width of first mate solder pins	
GG3	0.75	+0 / -0.1	Width of second mate solder pins	
HH3	2.25	+/- 0.1	Height of second mate solder pins	
JJ3	0.5	+/- 0.2	Height of board stand-off at solder pins	
KK3	3.25	+/-0.1	Height of first mate solder pins	
LL3	45.0	+/-0.2	Overall width of rail system	
MM3	4.0	+/-0.1	Width of guide features	
NN3	5.7	+/- 0.1	Local vertical height of hard stop to module	
PP3	5.55	+/- 0.1	Local vertical height of hard stop to module	

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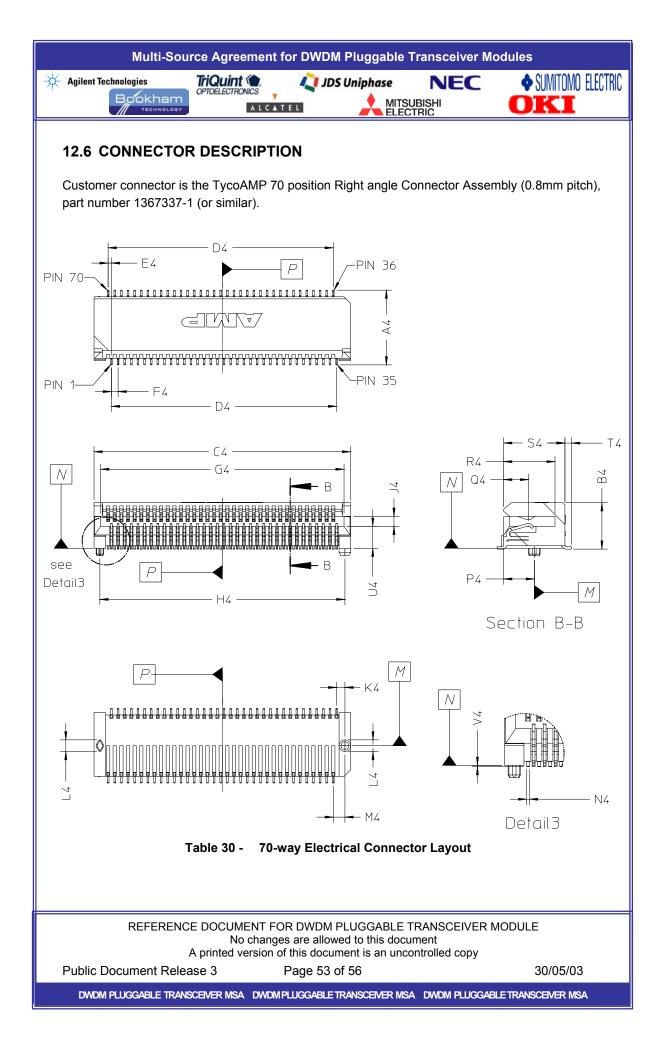
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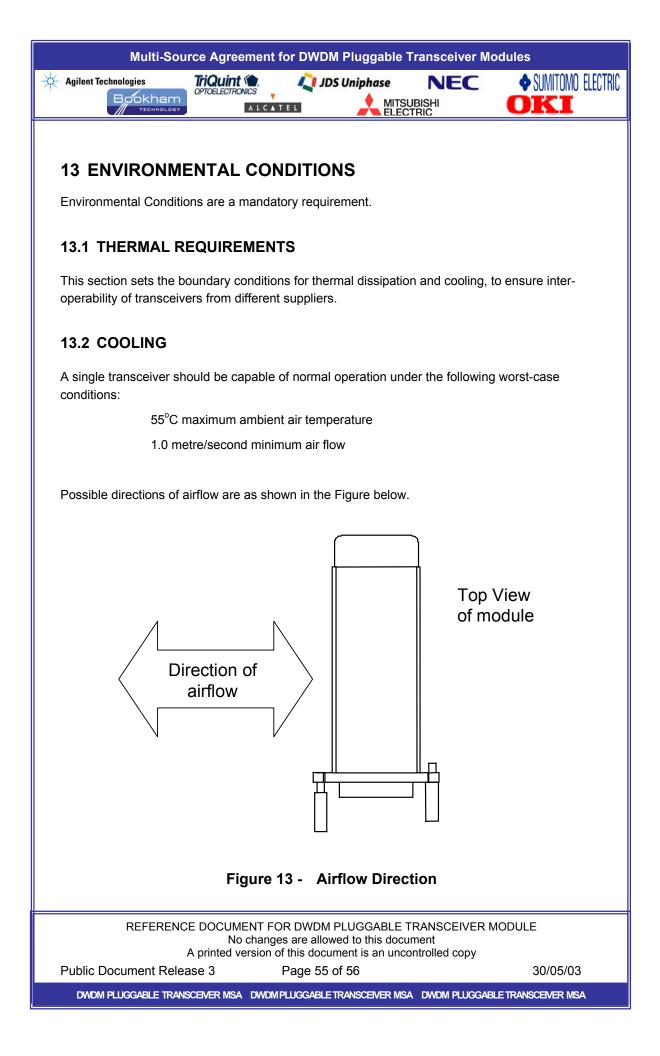
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Agilent Te QQ3 RR3 RSS3 TT3 UU3 RVV3	4.8			Sumitomo electric				
QQ3 RR3 RSS3 TT3 UU3	Bookh TECHI 4.8	OPTOELECTRONIC						
RR3 RSS3 TT3 UU3	4.8	NOLOGY						
RR3 RSS3 TT3 UU3								
RR3 RSS3 TT3 UU3								
RSS3 TT3 UU3		+/-0.1	Local vertical height of hard stop to module					
TT3 UU3	0.5	+/- 0.1	Flat section of strengthening feature					
UU3	0.5	+/- 0.1	Radius of strengthening feature					
	0.25	MAX	Max allowable protrusion for strengthening f					
RVV2	0.6	+/- 0.1	Horizontal position for center of radius of for	med feature				
	1.0	+/- 0.1	Radius of formed rail feature					
WW3	2.8	+/- 0.1	Vertical position of formed rail feature					
XX3	62.1	+/- 0.15	Position of location feature					
	Table 29 - Definition of Rail System Dimensions							
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Agilent Technologies TriQuint 🌰 💜 JDS Uniphase NEC 🔶 SUMITOMO ELEC						
		n				
KEY	VALUE (mm)	TOLERANCE (mm)	COMMENTS			
A4	9.2	Max	Connector length			
B4	5.9	Max	Connector height			
C4	31.2	Max	Connector width			
D4	27.2	Ref.	Contact array width			
E4	0.4	Тур.	Offset of second row of contacts from first			
F4	0.8	Тур.	Pitch of contacts			
G4	29.4	+/-0.08	Connector card slot width			
H4	29.6	TP	Distance between guide pins			
J4	1.35	Max	Connector Card Slot Height			
K4	1.0		Round guide pin to PIN 35			
L4	1.4		Width of guide pins			
M4	1.4		Round guide pin to PIN 36 Width of contacts			
N4 P4	0.2 3.7		Datum M to mouth of connector card slot			
P4 Q4	3.0	Max				
Q4	5.0	WIAX	Depth of contact point from mouth of connector card slot			
R4	6.0	Min	Depth of card slot from mouth of connector card slot			
S4	7.4		Back of connector from mouth of connector card slo			
T4	0.8		Length of solder leads past housing, front and rear			
U4 V4	2.6 0.1	Min +0.1-0.13	Datum N to bottom of card slot Datum N to bottom of contacts			
			ay Electrical Connector Dimensions			
	DATUM		DESCRIPTION			
	м	Centre vertical	plane of guide pins			
	N Bottom of connector stand off surfaces					
	N	P Centre vertical plane of connector				
		Centre vertical	plane of connector			
			plane of connector way Electrical Connector Datums			
			-			
			-			
			-			
			-			
			-			
			-			
	P	Table 32 - 70-	-			





14 PIN ASSIGNMENT

Top Row			Bottom Row			
Mating sequence	Pin	Description	Description	Pin	Mating Sequence	
1	70	Gnd (Tx)	Vcc (TEC)	1	2	
1	69	Gnd (Tx)	Vcc (TEC)	2	2	
3	68	TxClk (-ve)	Vcc (TEC)	3	2	
3	67	TxClk (+ve)	Gnd (TEC)	4	1	
1	66	Gnd (Tx)	Gnd (TEC)	5	1	
3	65	Reserved	Gnd (TEC)	6	1	
3	64	Reserved	Vcc (Tx)	7	2	
1	63	Gnd (Tx)	Vcc (Tx)	8	2	
3	62	Reserved	Gnd (Digital)	9	1	
3	61	Reserved	SDA		3	
1	60	Gnd (Tx)	SCL		3	
3	59	Reserved	Module Enable	12	3	
3	58	Reserved	Vcc (Digital)	13	2	
1	57	Gnd (Tx)	Gnd (Digital)	14	1	
3	56	Tx Data (-ve)	Tx Disable		3	
3	55	Tx Data (+ve)	Tx Alarm	16	3	
1	54	Gnd (Tx)	Tone Input	17	3	
1	53	Gnd (Tx)	Tone Output	18	3	
1	52	Gnd (Rx)	Rx Alarm	19	3	
3	51	Reserved	Rx LOS	20	3	
3	50	Reserved	SLA-AD2	21	3	
1	49	Gnd (Rx)	SLA-AD1	22	3	
3	48	Reserved	SLA-AD0	23	3	
3	47	Reserved	Vendor Reserved		3	
1	46	Gnd (Rx)	Vendor Reserved	25	3	
3	45	Reserved	Vendor Reserved	26	3	
3	44	Reserved	Vendor Reserved	27	3	
1	43	Gnd (Rx)	Vendor Reserved	28	3	
3	42	Rx Data (-ve)	Module Sense	29	3	
3	41	Rx Data (+ve)	Vcc (Rx)		2	
1	40	Gnd (Rx)	Vcc (Rx)	31	2	
3	39	Rx Clk (-ve)	Vcc (Rx Bias)		2	
3	38	Rx Clk (+ve)	Gnd (Rx Bias)	33	1	
1	37	Gnd (Rx)	Gnd (Rx Bias)		1	
1	36	Gnd (Rx)	Gnd (Rx)	35	1	

Notes:-

1) "Reserved" Pins are reserved by the MSA for future function. These are " No user Connect"

(ie. should not be connected to ground) 2) "Vendor Reserved" Pins are reserved vendor specific function. For connection, refer to vendor datasheet.

3) All ground connections should have the same potential

Module Status Outputs	Management Input/Output
Module Control Inputs	Positive Supply Voltage
Clock/Data Input/Output	Negative Supply Voltage
Vendor Specific Functions	Reserved Functionality (MSA)

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